

# REALTEK

**NOT FOR PUBLIC RELEASE**

RTL8201F-VB-CG  
RTL8201FL-VB-CG  
RTL8201FN-VB-CG

**SINGLE-CHIP/PORT 10/100M ETHERNET  
PHYCEIVER WITH AUTO MDIX**

**DATASHEET**

(CONFIDENTIAL: Development Partners Only)

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**USING THIS DOCUMENT**

This document is intended for the software engineer's reference and provides detailed programming information.

Though every effort has been made to ensure that this document is current and accurate, more information may have become available subsequent to the production of this guide.

## REVISION HISTORY

Revision	Release Date	Summary
1.0	2010/12/17	First release.
1.1	2011/02/18	Revised to VB model. Revised Table 22 Register 30 Interrupt Indicators and SNR Display Register, page 21. Added interrupt function. Added MMD Register Mapping and Definition section. Revised section 8.2 Interrupt, page 31. Revised Table 46 Absolute Maximum Ratings, page 44. Revised 9.1.3 Power On and PHY Reset Sequence, page 45. Revised Table 49 RMII Input Mode Power Dissipation (Whole System), page 46.
1.2	2011/04/21	Revised Figure 2 Block Diagram, page 4. Revised Table 3 RMII Interface, page 10. Revised Table 7 Device Configuration Interface, page 11. Revised Table 9 Reset and Other Pins, page 14. Revised Table 11 Register 0 Basic Mode Control Register, page 15. Revised Table 15 Register 4 Auto-Negotiation Advertisement Register (ANAR), page 17. Revised Table 20 Register 24, page 20. Revised Table 24 Page4 Register 16 EEE Capability Enable Register, page 22. Revised Table 25 Page4 Register 21 EEE Capability Register, page 22. Revised Table 30 Page7 Register 19, page 24. Added section 7.21 Page7 Register 24 Spread Spectrum Clock Register, page 25. Revised section 8.1.2 Serial Management Interface, page 29. Revised section 8.7 Reset and Transmit Bias, page 38. Added section 8.13 Spread Spectrum Clock (SSC), page 43. Added Figure 21 MII Interface Setup/Hold Time Definitions, page 47. Added Figure 26 RMII Interface Setup, Hold Time, and Output Delay Time Definitions, page 49. Added Figure 28 MDC/MDIO Interface Setup, Hold Time, and Valid from MDC Rising Edge Time Definitions, page 51.
1.3	2011/07/14	Added Figure 1 Application Diagram, page 3. Revised Table 30 Page7 Register 19 Interrupt, WOL Enable, and LEDs Function Registers, page 24. Added Table 34 EEPC1R (PCS Control 1 Register, MMD Device 3, Address 0x00), page 25. Added Table 35 EEPS1R (PCS Status 1 Register, MMD Device 3, Address 0x01), page 26. Added section 8.4.1 LED and PHY Address, page 32. Added section 8.4.8 EEE LED, page 36. Revised section 8.7 Reset and Transmit Bias, page 38.
1.4	2011/11/30	Revised Figure 2 Block Diagram, page 4. Revised Table 4 Clock Interface, page 10 (CKXTAL2 pin revised from I to IO).
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1.6	2012/11/27	Added 'Note that changing reserved bits of the registers made lead to loss of functions and unpredictable behavior' to section 7 Register Descriptions, page 15.
1.7	2014/07/24	Revised Table 53 RMII Transmission and Reception Cycle Timing, page 50. Revised Table 56 Oscillator Requirements, page 53. Revised Table 57 Clock Requirements, page 54.
1.8	2014/10/21	Revised Table 46 Absolute Maximum Ratings, page 44. Revised Table 50 Input Voltage: Vcc, page 46.

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## 1. General Description

The RTL8201F-VB-CG, RTL8201FL-VB-CG, and RTL8201FN-VB-CG are single-chip/single-port 10/100Mbps Ethernet PHYceivers that support:

- MII (Media Independent Interface)
- RMII (Reduced Media Independent Interface)

The RTL8201F/FL/FN implement all 10/100M Ethernet Physical-layer functions including the Physical Coding Sublayer (PCS), Physical Medium Attachment (PMA), Twisted Pair Physical Medium Dependent Sublayer (TP-PMD), 10Base-TX Encoder/Decoder, and Twisted-Pair Media Access Unit (TPMAU). The RTL8201F/FL/FN support auto MDIX.

A PECL (Pseudo Emitter Coupled Logic) interface is supported to connect with an external 100Base-FX fiber optical transceiver. The chip utilizes an advanced CMOS process to meet low voltage and low power requirements. With on-chip DSP (Digital Signal Processing) technology, the chip provides excellent performance under all operating conditions.

*Note: Version differences are listed in section 11 Ordering Information, page 58.*

## 2. Features

- Supports IEEE 802.3az-2010 (EEE)
- 100Base-TX IEEE 802.3u Compliant
- 10Base-T IEEE 802.3 Compliant
- Supports MII mode
- Supports RMII mode
- Full/half duplex operation
- Twisted pair or fiber mode output
- Supports Auto-Negotiation
- Supports power down mode
- Supports Link Down Power Saving
- Supports Base Line Wander (BLW) compensation
- Supports auto MDIX
- Supports Interrupt function
- Supports Wake-On-LAN (WOL)
- Adaptive Equalization
- Automatic Polarity Correction
- LEDs
  - ◆ RTL8201F and RTL8201FL provide two network status LEDs
  - ◆ RTL8201FN provides three network status LEDs
- Supports 25MHz external crystal or OSC
- Supports 50MHz external OSC Clock input
- Provides 50MHz clock source for MAC
- Low power supply 1.1V and 3.3V; 1.1V is generated by an internal regulator
- 0.11 $\mu$ m CMOS process
- Packages:
  - ◆ 32-pin MII/RMII QFN ‘Green’ package (RTL8201F)
  - ◆ 48-pin MII/RMII LQFP ‘Green’ package (RTL8201FL)
  - ◆ 48-pin MII/RMII QFN ‘Green’ package (RTL8201FN)

### 3. Applications

- DTV (Digital TV)
- MAU (Media Access Unit)
- CNR (Communication and Network Riser)
- Game Console
- Printer and Office Machine
- DVD Player and Recorder
- Ethernet Hub
- Ethernet Switch

In addition, the RTL8201F/FL/FN can be used in any embedded system with an Ethernet MAC that needs a UTP physical connection or Fiber PECL interface to an external 100Base-FX optical transceiver module.

#### 3.1. Application Diagram

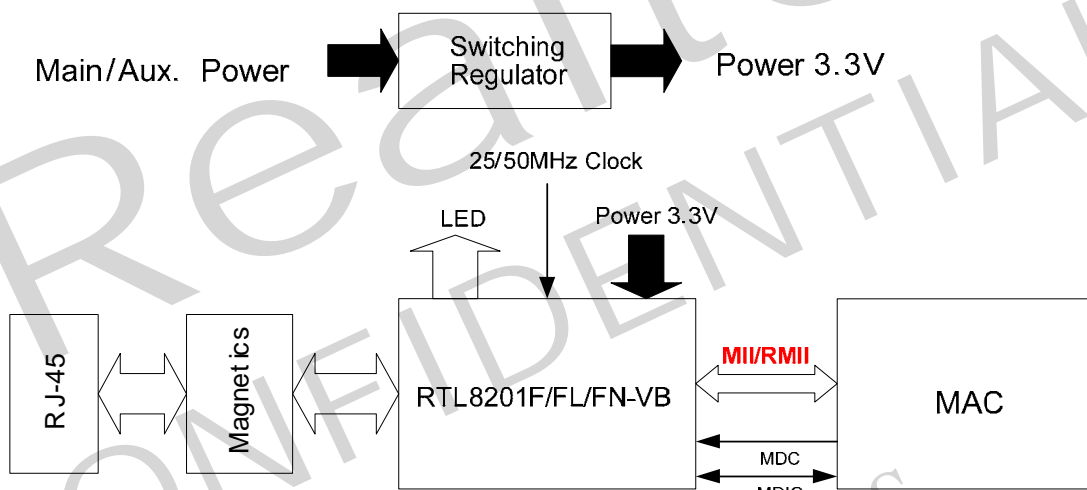
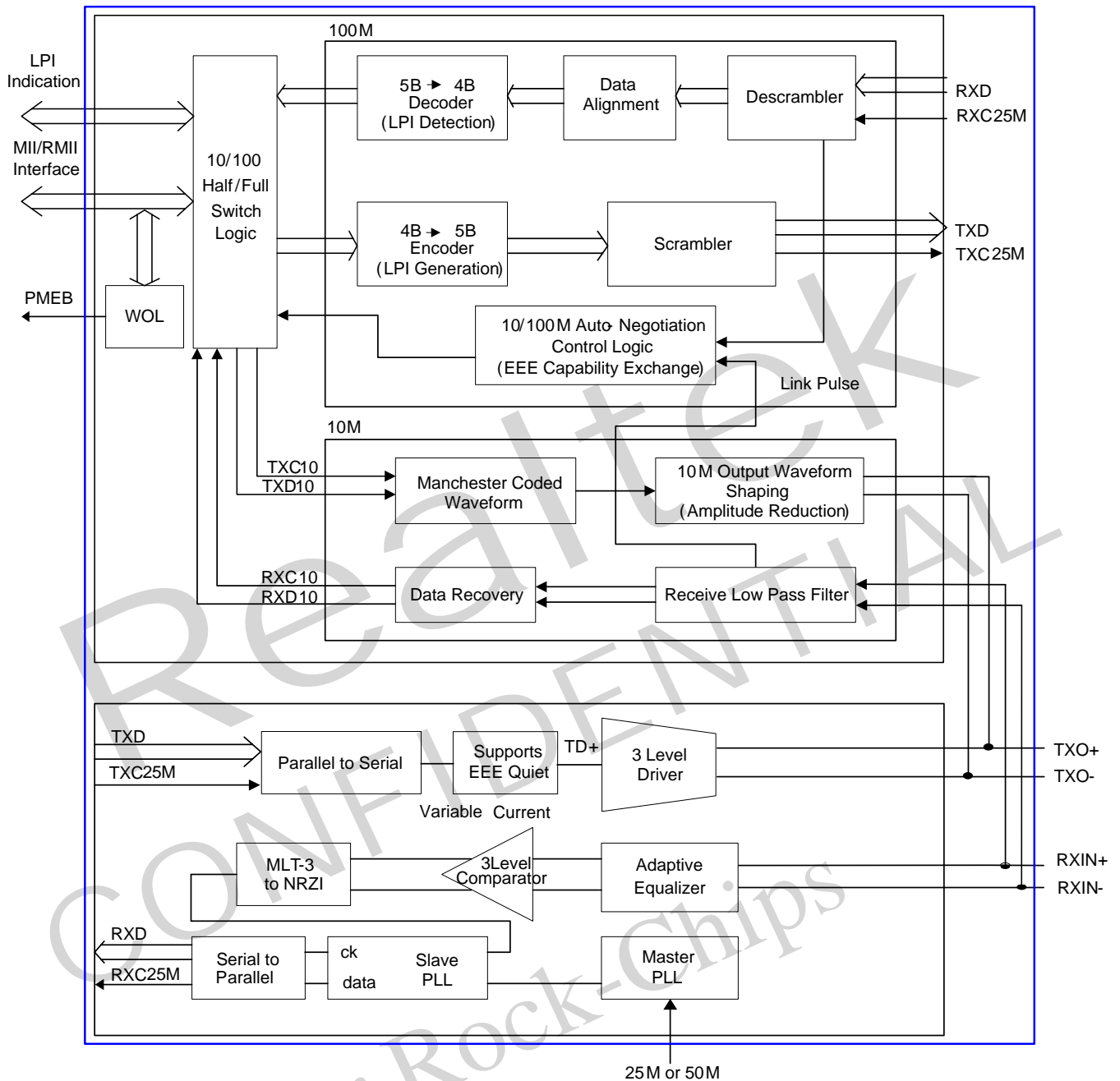


Figure 1. Application Diagram

## 4. Block Diagram



**Figure 2. Block Diagram**

## 5. Pin Assignments

### 5.1. RTL8201F (32-Pin)

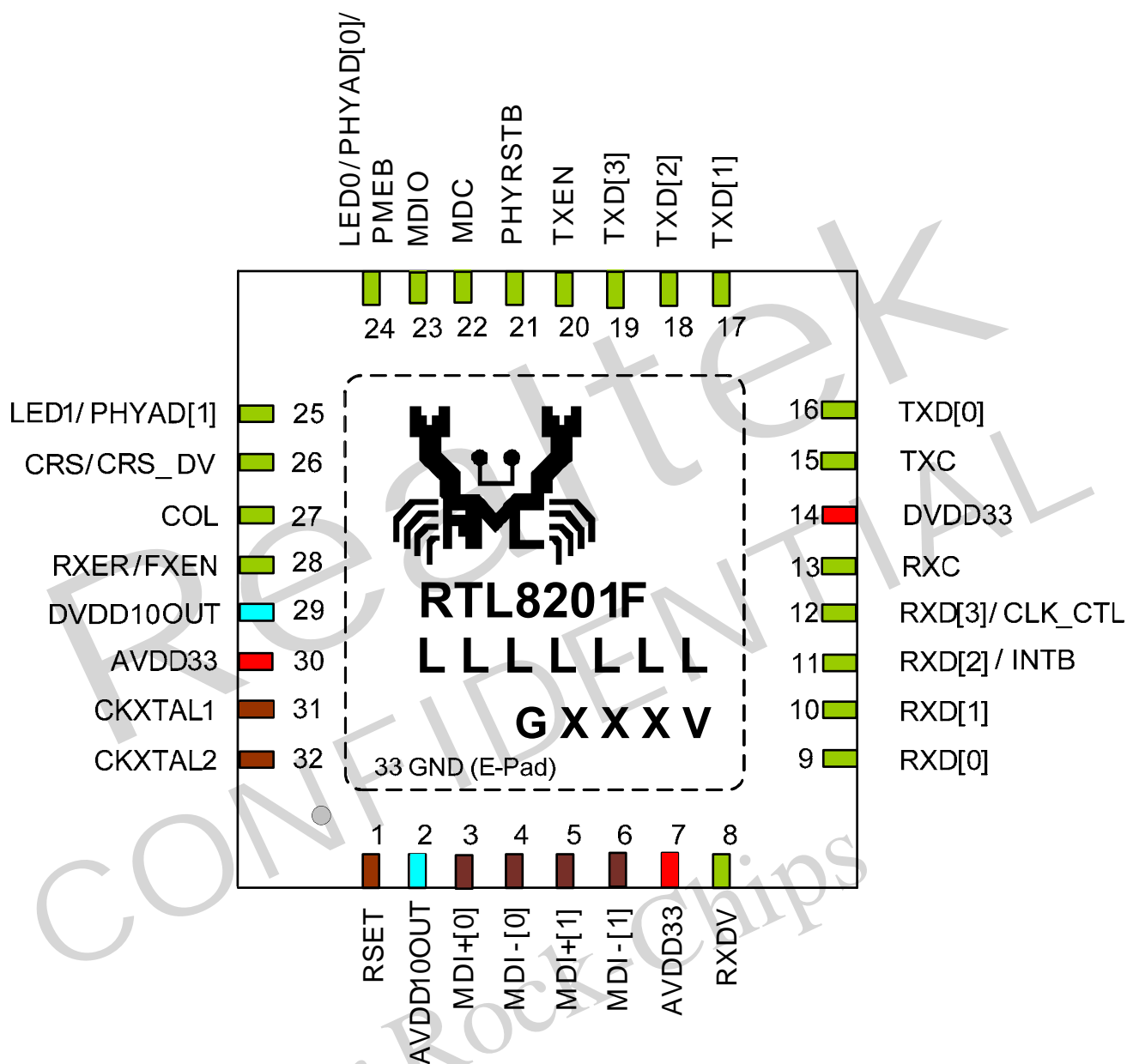


Figure 3. RTL8201F QFN-32 Pin Assignments

### 5.2. Green Package and Version Identification

Green package is indicated by the 'G' in GXXXV (Figure 3). The version is shown in the location marked 'V'.

### 5.3. RTL8201FL (48-Pin)

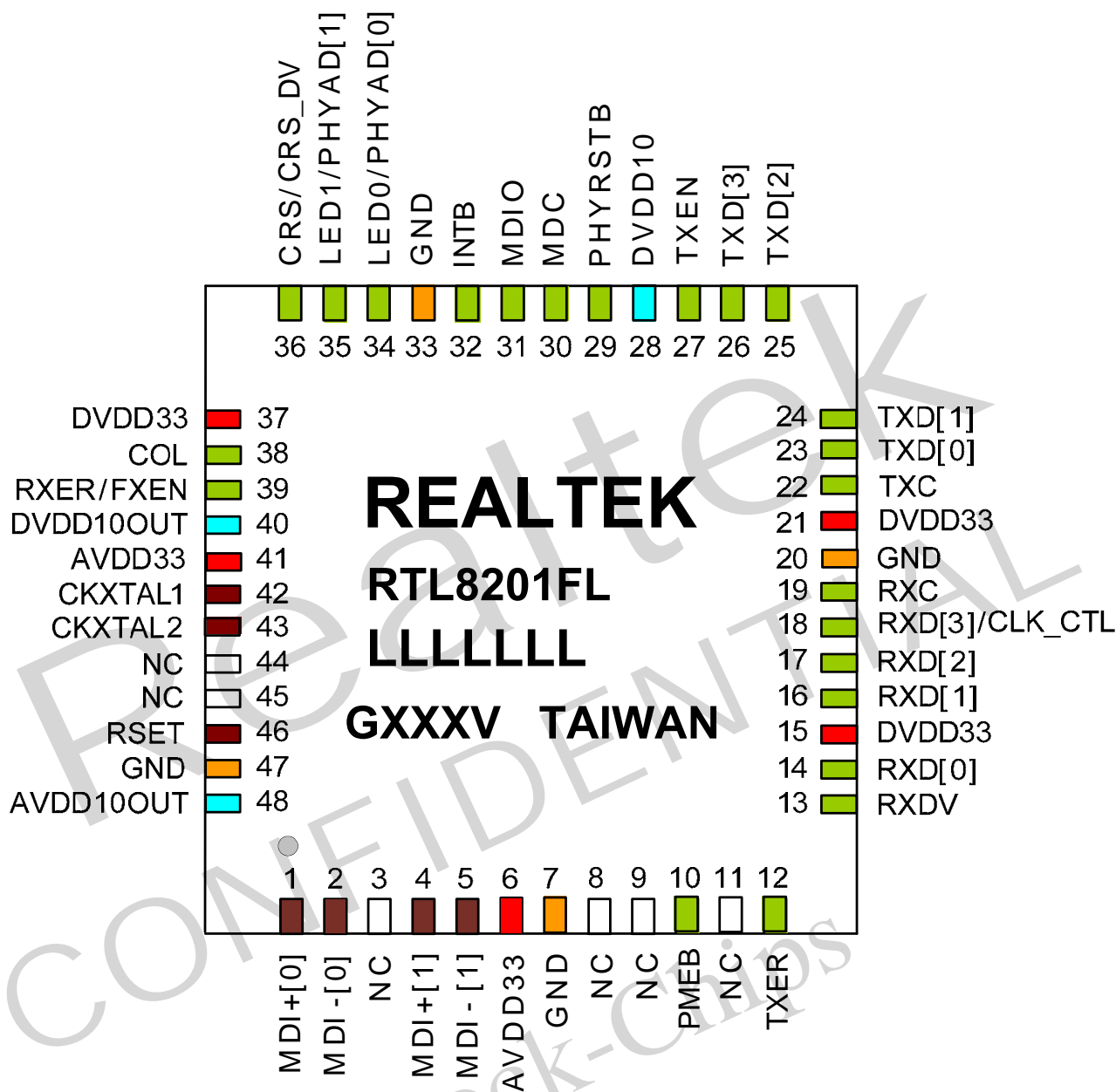


Figure 4. RTL8201FL LQFP-48 Pin Assignments

### 5.4. Green Package and Version Identification

Green package is indicated by the 'G' in GXXXV (Figure 4). The version is shown in the location marked 'V'.

### 5.5. RTL8201FN (48-Pin)

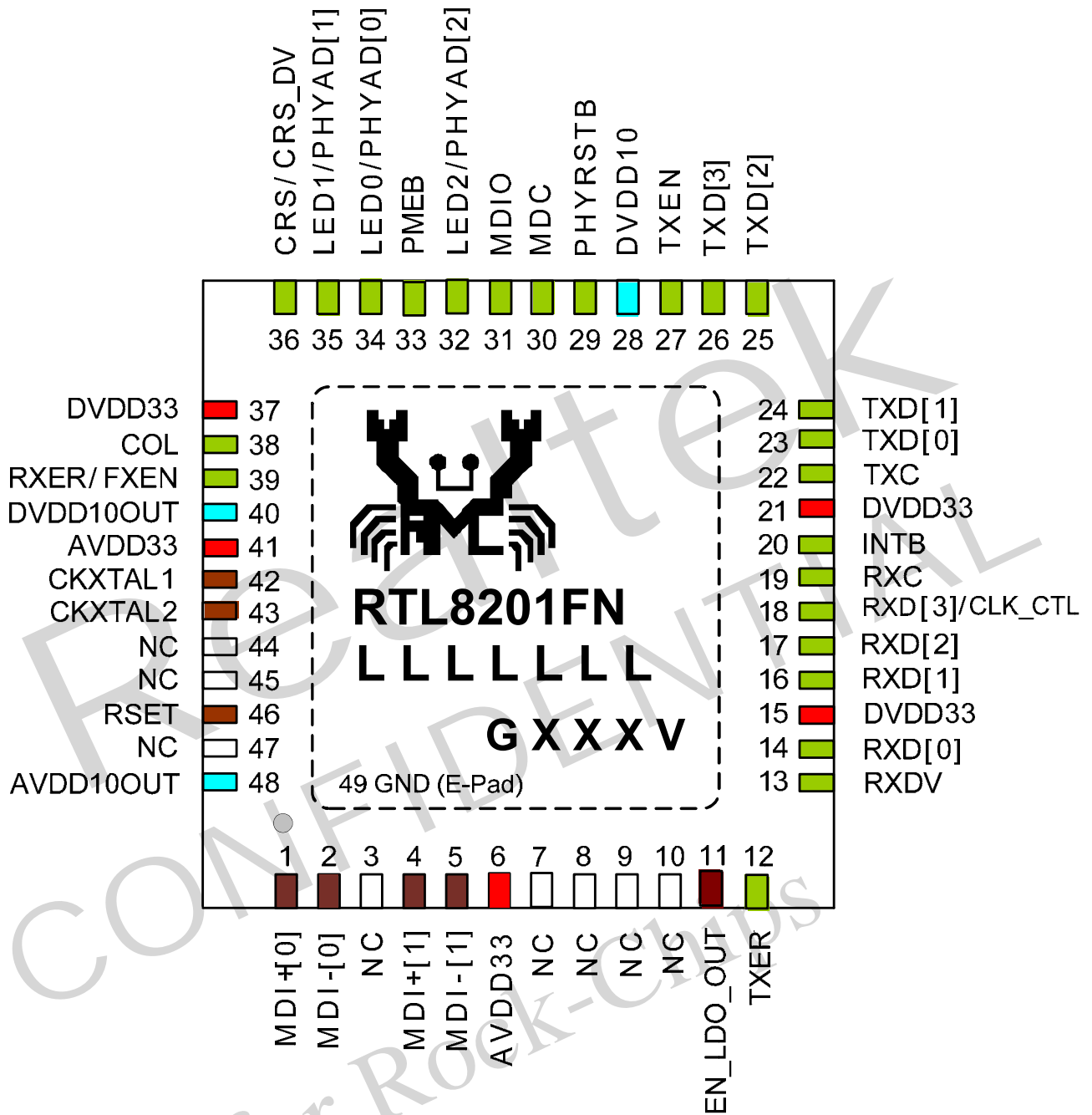


Figure 5. RTL8201FN QFN-48 Pin Assignments

### 5.6. Green Package and Version Identification

Green package is indicated by the 'G' in GXXXXV (Figure 5). The version is shown in the location marked 'V'.



## 6. Pin Descriptions

I: Input

LI: Latched Input during Power up or Reset

O: Output

IO: Bi-directional Input and Output

P: Power

HZ: High Impedance During Power On Reset

PU: Internal Pull Up During Power On Reset

PD: Internal Pull Down During Power On Reset

OD: Open Drain Output

### 6.1. MII Interface

**Table 1. MII Interface**

Name	Type	Pin No. (8201F)	Pin No. (8201FL)	Pin No. (8201FN)	Description
TXC	O/PD	15	22	22	Transmit Clock. This pin provides a continuous clock as a timing reference for TXD [3:0] and TXEN signals. TXC is 25MHz in 100Mbps mode and 2.5MHz in 10Mbps mode.
TXEN	I/PD	20	27	27	Transmit Enable. The input signal indicates the presence of valid nibble data on TXD [3:0]. An internal weakly pulled low resistor prevents the bus floating.
TXER	I/PD	-	12	12	Transmit Error.
TXD[0]	I/PD	16	23	23	Transmit Data. The MAC will source TXD [0:3] synchronous with TXC when TXEN is asserted. An internal weakly pulled low resistor prevents the bus floating.
TXD[1]	I/PD	17	24	24	
TXD[2]	I/PD	18	25	25	
TXD[3]	I/PD	19	26	26	
RXC	O/PD	13	19	19	Receive Clock. This pin provides a continuous clock reference for RXDV and RXD [0:3] signals. RXC is 25MHz in 100Mbps mode and 2.5MHz in 10Mbps mode.
COL	O/PD	27	38	38	Collision Detect. COL is asserted high when a collision is detected on the media.
CRS/ CRS_DV	O/PD	26	36	36	Carrier Sense. This pin's signal is asserted high if the media is not in Idle state.

Name	Type	Pin No. (8201F)	Pin No. (8201FL)	Pin No. (8201FN)	Description
RXDV	LI/O/PD	8	13	13	<p>Receive Data Valid.</p> <p>This pin's signal is asserted high when received data is present on the RXD[3:0] lines. The signal is de-asserted at the end of the packet. The signal is valid on the rising edge of the RXC.</p> <p>This pin should be pulled low when operating in MII mode.</p> <p>0: MII mode 1: RMII mode</p> <p>An internal weakly pulled low resistor sets this to the default of MII mode. It is possible to use an external 4.7K<math>\Omega</math> pulled high resistor to enable RMII mode.</p> <p>After power on, the pin operates as the Receive Data Valid pin.</p>
RXD[0]	O/PD	9	14	14	Receive Data.
RXD[1]	LI/O/PD	10	16	16	These are the four parallel receive data lines aligned on the nibble boundaries driven synchronously to the RXC for reception by the external physical unit (PHY).
RXD[2]	O/PD	-	17	17	<i>Note 1: An internal weakly pulled low resistor sets RXD[1] to the LED function (default). Use an external 4.7K<math>\Omega</math> pulled high resistor to enable the WOL function for the RTL8201F.</i>
RXD[2]/INTB	O/PD	11	-	-	<i>Note 2: The RTL8201F Pin11 is named RXD[2]/INTB. When in RMII mode, this pin is used for the interrupt function. See Table 9, page 14 for INTB descriptions.</i>
RXD[3]/CLK_CTL	LI/O/PD	12	18	18	<p>Receive Data.</p> <p>This is the parallel receive data line aligned on the nibble boundaries driven synchronously to the RXC for reception by the external physical unit (PHY).</p> <p>RXD[3]/CLK_CTL pin is the Hardware strap in RMII Mode.</p> <p>1: REF_CLK input mode 0: REF_CLK output mode</p> <p><i>Note: An internal weakly pulled low resistor sets RXD[3]/CLK_CTL to REF_CLK output mode (default).</i></p>
RXER/FXEN	LI/O/PD	28	39	39	<p>Receive Error.</p> <p>If a 5B decode error occurs, such as invalid /J/K/, invalid /T/R/, or invalid symbol, this pin will go high.</p> <p>Fiber/UTP Enable.</p> <p>This pin's status is latched at power on reset to determine the media mode to operate in:</p> <p>1: Fiber mode 0: UTP mode</p> <p>An internal weakly pulled low resistor sets this to the default of UTP mode. It is possible to use an external 4.7K<math>\Omega</math> pulled high resistor to enable fiber mode. After power on, the pin operates as the Receive Error pin.</p>

## 6.2. Serial Management Interface

**Table 2. Serial Management Interface**

Name	Type	Pin No. (8201F)	Pin No. (8201FL)	Pin No. (8201FN)	Description
MDC	I/PU	22	30	30	Management Data Clock. This pin provides a clock synchronous to MDIO, which may be asynchronous to the transmit TXC and receive RXC clocks. The clock rate can be up to 2.5MHz. Use an internal weakly pulled high resistor to prevent the bus floating.
MDIO	IO/PU	23	31	31	Management Data Input/Output. This pin provides the bi-directional signal used to transfer management information.

## 6.3. RMII Interface

**Table 3. RMII Interface**

Name	Type	Pin No. (8201F)	Pin No. (8201FL)	Pin No. (8201FN)	Description
TXC	IO/PD	15	22	22	Synchronous 50MHz Clock Reference for Receive, Transmit, and Control Interface. The direction is decided by Page7, Register 16. The default direction is reference clock output mode if RXD[3]/CLK_CTL pin floating.
CRS/ CRS_DV	O/PD	26	36	36	Carrier Sense/Receive Data Valid. CRS_DV shall be asserted by the PHY when the receive medium is non-idle.
TXEN	I/PD	20	27	27	Transmit Enable.
TXD[0:1]	I/PD	16, 17	23, 24	23, 24	Transmit Data.
RXD[0:1]	O/PD	9, 10	14, 16	14, 16	Receive Data.
RXER/ FXEN	LI/O/PD	28	39	39	Receive Error. RX_ER is a required output of the PHY, but is an optional input for the MAC.

## 6.4. Clock Interface

**Table 4. Clock Interface**

Name	Type	Pin No. (8201F)	Pin No. (8201FL)	Pin No. (8201FN)	Description
CKXTAL2	IO	32	43	43	25MHz Crystal Output. This pin provides the 25MHz crystal output. If an external 25MHz/50MHz oscillator or clock is used, connect CKXTAL2 to the oscillator or clock output (see section 9.4 Oscillator Requirements, page 53).
CKXTAL1	I	31	42	42	25MHz Crystal Input. This pin provides the 25MHz crystal input. Must be shorted to GND when an external 25MHz/50MHz oscillator or clock drives CKXTAL2.

## 6.5. 10/100Mbps Network Interface

**Table 5. 10/100Mbps Network Interface**

Name	Type	Pin No. (8201F)	Pin No. (8201FL)	Pin No. (8201FN)	Description
MDI+[0] MDI-[0]	IO	3 4	1 2	1 2	Transmit Output. Differential transmit output pair shared by 100Base-TX, 100Base-FX, and 10Base-T modes. When configured as 100Base-TX, output is an MLT-3 encoded waveform. When configured as 100Base-FX, the output is pseudo-ECL level.
MDI+[1] MDI-[1]	IO	5 6	4 5	4 5	Receive Input. Differential receive input pair shared by 100Base-TX, 100Base-FX, and 10Base-T modes.

## 6.6. Transmit Bias Reference

**Table 6. Transmit Bias Reference**

Name	Type	Pin No. (8201F)	Pin No. (8201FL)	Pin No. (8201FN)	Description
RSET	I	1	46	46	Transmit Bias Resistor Connection. This pin should be pulled to GND by a 2.49K $\Omega$ (1%) resistor to define driving current for the transmit DAC.

## 6.7. Device Configuration Interface

**Table 7. Device Configuration Interface**

Name	Type	Pin No. (8201F)	Pin No. (8201FL)	Pin No. (8201FN)	Description
RXDV	LI/O/PD	8	13	13	Receive Data Valid. This pin's signal is asserted high when received data is present on the RXD [3:0] lines. The signal is de-asserted at the end of the packet. The signal is valid on the rising edge of the RXC. This pin should be pulled low when operating in MII mode. 0: MII mode 1: RMII mode An internal weakly pulled low resistor sets this to the default of MII mode. It is possible to use an external 4.7K $\Omega$ pulled high resistor to enable RMII mode. After power on, the pin operates as the Receive Data Valid pin.
RXD[1]	LI/O/PD	10	16	16	An internal weakly pulled low resistor sets RXD[1] to the LED function (default). Use an external 4.7K $\Omega$ pulled high resistor to enable the WOL function for the RTL8201F.

Name	Type	Pin No. (8201F)	Pin No. (8201FL)	Pin No. (8201FN)	Description																														
LED0/ PHYAD[0]	LI/O/PU	-	34	34	<p>PHY Address and Customized LED Settings.</p> <p>The default available PHY addresses are: RTL8201F: 00000~00011 RTL8201FL: 00100~00111 (when PMEB pin is pulled high) 00000~00011 (when PMEB pin is pulled low) RTL8201FN: 00000~00111</p> <p><i>Note 1: The PHY will respond with PHY_AD=00 regardless of whether PHYAD[1:0] settings are non-zero (RTL8201F/RTL8201FL).</i></p> <p><i>Note 2: The PHY will respond with PHY_AD=00 regardless of whether PHYAD[2:0] settings are non-zero (RTL8201FN).</i></p> <p><b>Traditional LED Function Selection</b></p> <table><tr><th>LED_Sel</th><th>00</th><th>01</th><th>10</th><th>11</th></tr><tr><td>LED0</td><td>ACT<sub>ALL</sub></td><td>Link<sub>ALL</sub>/ ACT<sub>ALL</sub></td><td>Link<sub>10</sub>/ ACT<sub>ALL</sub></td><td>LINK<sub>10</sub>/ ACT<sub>10</sub></td></tr><tr><td>LED1</td><td>LINK<sub>100</sub></td><td>LINK<sub>100</sub></td><td>LINK<sub>100</sub></td><td>LINK<sub>100</sub>/ ACT<sub>100</sub></td></tr><tr><td>LED2</td><td>Reserved</td><td>Reserved</td><td>Reserved</td><td>Reserved</td></tr></table> <p><i>Note 1: For customized LED settings, see section 7.17, page 23.</i></p> <p><i>Note 2: LED_Sel default is 11. Refer to section 7.19, page 24.</i></p> <p>An internal weakly pulled low resistor sets RXD[1] to the LED function for RTL8201F (default). Use an external 4.7K<math>\Omega</math> pulled high resistor to enable the WOL function for RTL8201F.</p> <p><b>Traditional LED Function Selection for the RTL8201F with WOL Enabled</b></p> <p>With the RTL8201F WOL function enabled, the PHY address must be 00001 or 00011.</p> <table><tr><th>LED_Sel</th><th>00</th><th>01</th><th>10</th><th>11</th></tr><tr><td>LED1</td><td>LINK<sub>100</sub></td><td>LINK<sub>100</sub></td><td>LINK<sub>100</sub></td><td>LINK<sub>100</sub>/ ACT<sub>100</sub></td></tr></table>	LED_Sel	00	01	10	11	LED0	ACT <sub>ALL</sub>	Link <sub>ALL</sub> / ACT <sub>ALL</sub>	Link <sub>10</sub> / ACT <sub>ALL</sub>	LINK <sub>10</sub> / ACT <sub>10</sub>	LED1	LINK <sub>100</sub>	LINK <sub>100</sub>	LINK <sub>100</sub>	LINK <sub>100</sub> / ACT <sub>100</sub>	LED2	Reserved	Reserved	Reserved	Reserved	LED_Sel	00	01	10	11	LED1	LINK <sub>100</sub>	LINK <sub>100</sub>	LINK <sub>100</sub>	LINK <sub>100</sub> / ACT <sub>100</sub>
LED_Sel	00	01	10	11																															
LED0	ACT <sub>ALL</sub>	Link <sub>ALL</sub> / ACT <sub>ALL</sub>	Link <sub>10</sub> / ACT <sub>ALL</sub>	LINK <sub>10</sub> / ACT <sub>10</sub>																															
LED1	LINK <sub>100</sub>	LINK <sub>100</sub>	LINK <sub>100</sub>	LINK <sub>100</sub> / ACT <sub>100</sub>																															
LED2	Reserved	Reserved	Reserved	Reserved																															
LED_Sel	00	01	10	11																															
LED1	LINK <sub>100</sub>	LINK <sub>100</sub>	LINK <sub>100</sub>	LINK <sub>100</sub> / ACT <sub>100</sub>																															
LED0/ PHYAD[0]/ PMEB	LI/O/PU	24	-	-																															
LED1/ PHYAD[1]	LI/O/PD	25	35	35																															
LED2/ PHYAD[2]	LI/O/PD	-	-	32																															
RXD[3]/ CLK_CTL	LI/O/PD	12	18	18																															

RXD[3]/ CLK_CTL	LI/O/PD	12	18	18	<p>Receive Data.</p> <p>This is the parallel receive data line aligned on the nibble boundaries driven synchronously to the RXC for reception by the external physical unit (PHY). RXD [3]/CLK_CTL pin is the Hardware strap in RMII Mode.</p> <p>1: REF_CLK input mode 0: REF_CLK output mode</p> <p><i>Note: An internal weakly pulled low resistor sets RXD[3]/CLK_CTL to REF_CLK output mode (default).</i></p>
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Name	Type	Pin No. (8201F)	Pin No. (8201FL)	Pin No. (8201FN)	Description
RXER/ FXEN	LI/O/PD	28	39	39	Fiber/UTP Interface. This pin's status is latched at power on reset to determine the media mode to operate in. 1: Fiber mode 0: UTP mode An internal weakly pulled low resistor sets this to the default of UTP mode. It is possible to use an external 4.7K $\Omega$ pulled high resistor to enable fiber mode.
EN_LDO_ OUT	LI/O/PU	-	-	11	LDO Mode Strap. 1: LDO enable 2: LDO disable

## 6.8. Power and Ground Pins

**Table 8. Power and Ground Pins**

Name	Type	Pin No. (8201F)	Pin No. (8201FL)	Pin No. (8201FN)	Description
AVDD33	P	7, 30	6, 41	6, 41	3.3V Analog Power Input. 3.3V power supply for analog circuit; should be well decoupled.
DVDD33	P	14	15, 21, 37	15, 21, 37	3.3V Digital Power Input. 3.3V power supply for digital circuit.
DVDD10	P	-	28	28	1.1V Digital Power.
AVDD100OUT	O	2	48	48	Power Output. Be sure to connect a 0.1 $\mu$ F ceramic capacitor for decoupling purposes. The connection method is outlined in section 8.8 3.3V Power Supply and Voltage Conversion Circuit, page 38.
DVDD100OUT	O	29	40	40	Power Output. Be sure to connect a 0.1 $\mu$ F ceramic capacitor for decoupling purposes. The connection method is outlined in section 8.8 3.3V Power Supply and Voltage Conversion Circuit, page 38.
GND	P	E-PAD	7, 20, 33, 47	E-PAD	Ground. Should be connected to a larger GND plane. Exposed Pad (E-Pad) is Analog and Digital Ground.

## 6.9. Reset and Other Pins

**Table 9. Reset and Other Pins**

Name	Type	Pin No. (8201F)	Pin No. (8201FL)	Pin No. (8201FN)	Description
PHYRSTB	I/HZ	21	29	29	RESETB. Set low to reset the chip. For a complete reset, this pin must be asserted low for at least 10ms. <i>Note: When the WOL function is enabled, keep the pin high (RTL8201FN only).</i>
INTB	O/OD	-	32	20	Interrupt. Set low if link status changed, duplex changed, or auto negotiation failed. Active Low. This pin is an open-drain design, and for default value should be pulled high by an external 4.7K $\Omega$ . If not used, keep floating.
RXD[2]/INTB	O/PD	11	-	-	Interrupt. Set low if link status changed, duplex changed, or auto negotiation failed. Active Low. This pin is an open-drain design, and for default value should be pulled high by an external 4.7K $\Omega$ . If not used, keep floating. <i>Note: This pin is used for the interrupt function only when in the RMII mode.</i>
PMEB	O/OD	24	10	33	Power Management Enable. Set low if received a magic packet or wake up frame; active low.

## 6.10. NC (Not Connected) Pins

**Table 10. NC (Not Connected) Pins**

Name	Type	Pin No. (8201F)	Pin No. (8201FL)	Pin No. (8201FN)	Description
NC	-	-	3, 8, 9, 11, 44, 45	3, 7, 8, 9, 10, 44, 45, 47	Not Connected.



## 7. Register Descriptions

This section describes the functions and usage of the registers available in this file. In this section the following abbreviations are used. Note that changing reserved bits of the registers made lead to loss of functions and unpredictable behavior in the RTL8201F-VB-CG, RTL8201FL-VB-CG, and RTL8201FN-VB-CG.

RW: Read/Write

RW/EFUS: Read/Write/eFUSE Burnable

RO: Read Only

RW/LI: Read/Write/Latch In

RC: Read Clear

RW/SC: Read/Write/Self-Clearing

SC: Self-Clear

LH: Latched High

*Note: RW/EFUS and RW/LI types will return to default values after a software reset (set Reg.0 Bit15 to 1).*

### 7.1. Register 0 Basic Mode Control Register

### Table 11. Register 0 Basic Mode Control Register

<b>Address</b>	<b>Name</b>	<b>Description</b>	<b>Mode</b>	<b>Default</b>
0:15	Reset	This bit sets the status and control registers of the PHY in the default state. This bit is self-clearing. 1: Software reset                      0: Normal operation Register 0 and register 1 will return to default values after a software reset (set Bit15 to 1). This action may change the internal PHY state and the state of the physical link associated with the PHY.	RW/ SC	0
0:14	Loopback	This bit enables loopback of transmit data nibbles TXD3:0 to the receive data path. 1: Enable loopback                      0: Normal operation	RW	0
0:13	Speed Selection	This bit sets the network speed. 1: 100Mbps                                  0: 10Mbps After completing auto negotiation, this bit will reflect the speed status. 1: 100Base-T                                0: 10Base-T When 100Base-FX mode is enabled, this bit=1 and is read only.	RW	1
0:12	Auto Negotiation Enable	This bit enables/disables the NWay auto-negotiation function. 1: Enable auto-negotiation; bits 0:13 and 0:8 will be ignored 0: Disable auto-negotiation; bits 0:13 and 0:8 will determine the link speed and the data transfer mode, respectively When 100Base-FX mode is enabled, this bit=0 and is read only.	RW	1
0:11	Power Down	This bit turns down the power of the PHY chip, including the internal crystal oscillator circuit. The MDC, MDIO is still alive for accessing the MAC. 1: Power down                              0: Normal operation	RW	0

Address	Name	Description	Mode	Default
0:10	Isolate	1: Electrically isolate the PHY from MII/GMII/RGMII/RSGMII. PHY is still able to respond to MDC/MDIO. 0: Normal operation	RW	0
0:9	Restart Auto Negotiation	This bit allows the NWay auto-negotiation function to be reset. 1: Re-start auto-negotiation      0: Normal operation	RW/ SC	0
0:8	Duplex Mode	This bit sets the duplex mode if auto-negotiation is disabled (bit 0:12=0). 1: Full duplex      0: Half duplex After completing auto-negotiation, this bit will reflect the duplex status. 1: Full duplex      0: Half duplex	RW	1
0:7	Collision Test	Collision Test. 1: Collision test enabled 0: Normal operation When set, this bit will cause the COL signal to be asserted in response to the TXEN assertion within 512-bit times. The COL signal will be de-asserted within 4-bit times in response to the TXEN de-assertion.	RW	0
0:6	Speed Selection[1]	Speed Select Bit 1. Refer to bit 0:13.	RW	0
0:5~0	Reserved	Reserved.	-	-

## 7.2. Register 1 Basic Mode Status Register

**Table 12. Register 1 Basic Mode Status Register**

Address	Name	Description	Mode	Default
1:15	100Base-T4	1: Enable 100Base-T4 support 0: Suppress 100Base-T4 support	RO	0
1:14	100Base_TX_FD	1: Enable 100Base-TX full duplex support 0: Suppress 100Base-TX full duplex support	RO	1
1:13	100Base_TX_HD	1: Enable 100Base-TX half duplex support 0: Suppress 100Base-TX half duplex support	RO	1
1:12	10Base_T_FD	1: Enable 10Base-T full duplex support 0: Suppress 10Base-T full duplex support	RO	1
1:11	10Base_T_HD	1: Enable 10Base-T half duplex support 0: Suppress 10Base-T half duplex support	RO	1
1:10~7	Reserved	Reserved.	-	-
1:6	MF Preamble Suppression	The RTL8201F/FL/FN will accept management frames with preamble suppressed. A minimum of 32 preamble bits are required for the first management interface read/write transaction after reset. One idle bit is required between any two management transactions as per IEEE 802.3u specifications.	RO	1
1:5	Auto Negotiation Complete	1: Auto-negotiation process completed 0: Auto-negotiation process not completed	RO	0

Address	Name	Description	Mode	Default
1:4	Remote Fault	1: Remote fault condition detected (cleared on read) 0: No remote fault condition detected When in 100Base-FX mode, this bit means an in-band signal Far-End-Fault has been detected (see 8.10 Far End Fault Indication, page 39).	RC	0
1:3	Auto-Negotiation Ability	1: PHY is able to perform auto-negotiation 0: PHY is not able to perform auto-negotiation	RO	1
1:2	Link Status	1: Valid link established 0: No valid link established This bit indicates whether the link was lost since the last read. For the current link status, read this register twice.	RO	0
1:1	Jabber Detect	1: Jabber condition detected 0: No jabber condition detected	RO	0
1:0	Extended Capability	1: Extended register capable (permanently=1) 0: Not extended register capable	RO	1

### 7.3. Register 2 PHY Identifier Register 1

**Table 13. Register 2 PHY Identifier Register 1**

Address	Name	Description	Mode	Default
2:15~0	OUI	Composed of the 6 <sup>th</sup> to 21 <sup>st</sup> bits of the Organizationally Unique Identifier (OUI), respectively.	RO	001Ch

### 7.4. Register 3 PHY Identifier Register 2

**Table 14. Register 3 PHY Identifier Register 2**

Address	Name	Description	Mode	Default
3:15~10	OUI_LSB	Assigned to the 0 through 5 <sup>th</sup> bits of the OUI.	RO	110010
3:9~4	Model Number	Model Number	RO	000001
3:3~0	Revision Number	Revision Number	RO	0110

### 7.5. Register 4 Auto-Negotiation Advertisement Register (ANAR)

This register contains the advertised abilities of this device as they will be transmitted to its link partner during auto-negotiation.

**Table 15. Register 4 Auto-Negotiation Advertisement Register (ANAR)**

Address	Name	Description	Mode	Default
4:15	Next Page	Next Page Bit. 0: Transmitting the primary capability data page 1: Transmitting the protocol specific data page	RW	0
4:14	Acknowledge	1: Acknowledge reception of link partner capability data word 0: Do not acknowledge reception	RO	0

Address	Name	Description	Mode	Default
4:13	Remote Fault	1: Advertise remote fault detection capability 0: Do not advertise remote fault detection capability	RW	0
4:12	Reserved	Reserved.	-	-
4:11	Asymmetric PAUSE	1: Advertise asymmetric pause support 0: No support of asymmetric pause	RW	0
4:10	Pause	Reserved.	RW	0
4:9	100Base-T4	1: 100Base-T4 is supported by local node 0: 100Base-T4 not supported by local node	RO	0
4:8	100Base-TX-FD	1: 100Base-TX full duplex is supported by local node 0: 100Base-TX full duplex not supported by local node	RW	1
4:7	100Base-TX	1: 100Base-TX is supported by local node 0: 100Base-TX not supported by local node	RW	1
4:6	10Base-T-FD	1: 10Base-T full duplex supported by local node 0: 10Base-T full duplex not supported by local node	RW	1
4:5	10Base-T	1: 10Base-T is supported by local node 0: 10Base-T not supported by local node	RW	1
4:4~0	Selector Field	Binary Encoded Selector Supported by This Node. Currently only CSMA/CD 00001 is specified. No other protocols are supported.	RO	00001

## 7.6. Register 5 Auto-Negotiation Link Partner Ability Register (ANLPAR)

This register contains the advertised abilities of the Link Partner as received during auto-negotiation. The content changes after a successful auto-negotiation if Next-pages are supported.

**Table 16. Register 5 Auto-Negotiation Link Partner Ability Register (ANLPAR)**

Address	Name	Description	Mode	Default
5:15	Next Page	Next Page Bit. 0: Transmitting the primary capability data page 1: Transmitting the protocol specific data page	RO	0
5:14	Acknowledge	1: Link partner acknowledges reception of local node's capability data word 0: No acknowledgement	RO	0
5:13	Remote Fault	1: Link partner is indicating a remote fault 0: Link partner is not indicating a remote fault	RO	0
5:12	Reserved	Reserved.	-	-
5:11	Asymmetric Pause	1: Asymmetric Flow control supported by Link Partner 0: No Asymmetric flow control supported by Link Partner When auto-negotiation is enabled, this bit reflects Link Partner ability.	RO	0
5:10	Pause	1: Flow control supported by Link Partner 0: No flow control supported by Link Partner When auto-negotiation is enabled, this bit reflects Link Partner ability (read only).	RO	0

Address	Name	Description	Mode	Default
5:9	100Base-T4	1: 100Base-T4 is supported by link partner 0: 100Base-T4 not supported by link partner	RO	0
5:8	100Base-TX-FD	1: 100Base-TX full duplex is supported by link partner 0: 100Base-TX full duplex not supported by link partner	RO	0
5:7	100Base-TX	1: 100Base-TX is supported by link partner 0: 100Base-TX not supported by link partner This bit will also be set if the link in 100Base-TX is established by parallel detection.	RO	0
5:6	10Base-T-FD	1: 10Base-T full duplex is supported by link partner 0: 10Base-T full duplex not supported by link partner	RO	0
5:5	10Base-T	1: 10Base-T is supported by link partner 0: 10Base-T not supported by link partner This bit will also be set if the link in 10Base-T is established by parallel detection.	RO	0
5:4~0	Selector Field	Link Partner's Binary Encoded Node Selector. Currently only CSMA/CD 00001 is specified.	RO	00001

## 7.7. Register 6 Auto-Negotiation Expansion Register (ANER)

This register contains additional status for NWay auto-negotiation.

**Table 17. Register 6 Auto-Negotiation Expansion Register (ANER)**

Address	Name	Description	Mode	Default
6:15~5	Reserved	Reserved.	-	-
6:4	Parallel Detection Fault	1: A fault has been detected via the Parallel Detection function 0: No fault has been detected via the Parallel Detection function	RC	0
6:3	Link Partner Next Page Ability	1: Link Partner is Next Page able 0: Link Partner is not Next Page able	RO	0
6:2	Local Next Page Ability	1: Next Page is able 0: Not Next Page able	RO	0
6:1	Page Received	1: A New Page has been received 0: A New Page has not been received	RC	0
6:0	Link Partner Auto-Negotiation Ability	If Auto-Negotiation is Enabled, This Bit Means: 1: Link Partner is Auto-Negotiation able 0: Link Partner is not Auto-Negotiation able	RO	0

## 7.8. Page0 Register 13 MACR (MMD Access Control Register; Address 0x0D)

**Table 18. Page0 Register 13 MACR (MMD Access Control Register; Address 0x0D)**

Bit	Name	RW	Default	Description
13.15:14	Function	WO	0	00: Address 01: Data; no post increment 10: Data; post increment on reads and writes 11: Data; post increment on writes only
13.13:5	RSVD	RO	000000000	Reserved.
13.4:0	DEVAD	WO	0	Device Address.

Note 1: Used in conjunction with the MAADR (Register 14) to provide access to the MMD address space.

Note 2: If the access of MAADR is for address (Function=00) then it is directed to the address register within the MMD associated with the value in the DEVAD field.

Note 3: If the access of MAADR is for data (Function=00) then both the DEVAD field and the MMD address register direct the MAADR data accesses to the appropriate registers within the MMD.

## 7.9. Page0 Register 14 MAADR (MMD Access Address Data Register; Address 0x0E)

**Table 19. Page0 Register 14 MAADR (MMD Access Address Data Register; Address 0x0E)**

Bit	Name	RW	Default	Description
14.15:0	Address Data	RW	0x0000	13.15:14=00 → MMD DEVAD's address register 13.15:14=01, 10, or 11 → MMD DEVAD's data register as indicated by the contents of its address register

Note: Used in conjunction with the MACR (Register 13) to provide access to the MMD address space.

## 7.10. Register 24 Power Saving Mode Register (PSMR)

**Table 20. Register 24 Power Saving Mode Register (PSMR)**

Address	Name	Description	Mode	Default
24:15	Enpwrsave	Enable Power Saving Mode. The bit will return to default value by software reset.	RW	1
24:14~0	Reserved	Reserved.	-	-

Note: If the REF\_CLK output is needed in RMII output mode, LDPS (Link Down Power Saving) must be disabled (see Table 43, page 36).



## 7.11. Register 28 Fiber Mode and Loopback Register

**Table 21. Register 28 Fiber Mode and Loopback Register**

Address	Name	Description	Mode	Default
28:15~6	Reserved	Reserved.	-	-
28:5	Fxmode	Enable Fiber Mode.	RW	0
28:4~3	Reserved	Reserved.	-	-
28:2	En_autoMDIX	Enable Auto MDIX Function.	RW	1
28:1	Force_MDI	Force MDI/MDIX Mode. If enable auto MDIX function is disabled: 1: Force MDI 0: Force MDIX	RW	1
28:0	Reserved	Reserved.	-	-

## 7.12. Register 30 Interrupt Indicators and SNR Display Register

**Table 22. Register 30 Interrupt Indicators and SNR Display Register**

Address	Name	Description	Mode	Default
30:15	Anerr	Auto-Negotiation Error Interrupt. 1: Enable 0: Disable	RC	0
30:14	Spdchg	Speed Mode Change Interrupt. 1: Enable 0: Disable	RC	0
30:13	Duplexchg	Duplex Mode Change Interrupt. 1: Enable 0: Disable	RC	0
30:12	Reserved	Reserved.	-	-
30:11	Linkstatuschg	Link Status Change Interrupt. 1: Enable 0: Disable	RC	0
30:10~4	Reserved	Reserved.	-	-
30:3~0	SNR_O	These 4-Bits Show the Signal to Noise Ratio Value.	RO	0000

## 7.13. Register 31 Page Select Register

**Table 23. Register 31 Page Select Register**

Address	Name	Description	Mode	Default
31:15~8	Reserved	Reserved for Internal Testing.	-	-
31:7~0	PAGE SEL	Select Page Address: 00000000~11111111.	RW	00000000



## 7.14. Page4 Register 16 EEE Capability Enable Register

**Table 24. Page4 Register 16 EEE Capability Enable Register**

Address	Name	Description	Mode	Default
16:15~14	Reserved	Reserved.	-	-
16:13	EEE_10_cap	Enable EEE 10M Capability.	RW	1
16:12	EEE_nway_en	Enable Next Page Exchange in NWay for EEE 100M.	RW/ EFUS	1
16:11~10	Reserved	Reserved.	-	-
16:9	Tx_quiet_en	Enable Ability to Turn Off Power 100TX when TX in Quiet State. This bit is recommended to be set to 1 when EEE is enabled.	RW/ EFUS	1
16:8	Rx_quiet_en	Enable Ability to Turn Off Power 100RX when RX in Quiet state. This bit is recommended to be set to 1 when EEE is enabled.	RW/ EFUS	1
16:7:0	Reserved	Reserved.	-	-

## 7.15. Page4 Register 21 EEE Capability Register

**Table 25. Page4 Register 21 EEE Capability Register**

Address	Name	Description	Mode	Default
21:15~13	Reserved	Reserved.	-	-
21:12	Rg_dis_ldvt	Set to 1 to Disable the Line Driver of the Analog Circuit.	RW	0
21:11~1	Reserved	Reserved.	-	-
21:0	EEE_100_cap	NWay Result to Indicate Link Partner Supports EEE 100M.	RO	0

## 7.16. Page7 Register 16 RMII Mode Setting Register (RMSR)

**Table 26. Page7 Register 16 RMII Mode Setting Register (RMSR)**

Address	Name	Description	Mode	Default
16:15~13	Reserved	Reserved.	-	-
16:12	Rg_rmii_clkdir	This Bit Sets the Type of TXC in RMII Mode. 0: Output 1: Input	RW/LI	0
16:11~8	Rg_rmii_tx_offset	Adjust RMII TX Interface Timing.	RW/EFUS	1111
16:7~4	Rg_rmii_rx_offset	Adjust RMII RX Interface Timing.	RW/EFUS	1111
16:3	RMII Mode	0: MII Mode 1: RMII Mode	RW/LI	0
16:2	Rg_rmii_rxdv_sel	0: CRS/CRS_DV pin is CRS_DV signal 1: CRS/CRS_DV pin is RXDV signal	RW/EFUS	0
16:1	Rg_rmii_rxdsel	0: RMII data only 1: RMII data with SSD Error	RW/EFUS	1
16:0	Reserved	Reserved.	-	-

Note: Set Page7, Register 16 to '7FFB' when an external clock (25MHz and 50MHz) inputs to the CKXTAL2 pin.

## 7.17. Page7 Register 17 Customized LEDs Setting Register

This register is for setting customized LEDs. Table 27 shows the customized LED matrix table.

**Table 27. Customized LED Matrix Table**

	LINK		ACT
	10M	100M	
LED0	Bit0	Bit1	Bit3
LED1	Bit4	Bit5	Bit7
LED2	Bit8	Bit9	Bit11

LED Pin	ACT=0	ACT=1
LINK=0	Floating	All Speed ACT
LINK>0	Selected Speed LINK	Selected Speed LINK+ACT

*Note: The RTL8201F/FL only supports LED0 and LED1. The RTL8201FN supports LED0, LED1, and LED2.*

**Table 28. Page7 Register 17 Customized LEDs Setting Register**

Address	Name	Description	Mode	Default
17:15~12	Reserved	Reserved.	-	-
17:11~8	LED_sel2	Customized LED2 Setting. Set Bit3 (Page7 Register 19; Table 30, page 24) to 1 to enable customized LED function.	RW/ EFUS	0000
17:7~4	LED_sel1	Customized LED1 Setting. Set Bit3 (Page7 Register 19; Table 30, page 24) to 1 to enable customized LED function.	RW/ EFUS	0000
17:3~0	LED_sel0	Customized LED0 Setting. Set Bit3 (Page7 Register 19; Table 30, page 24) to 1 to enable customized LED function.	RW/ EFUS	0000

## 7.18. Page7 Register 18 EEE LEDs Enable Register

**Table 29. Page7 Register 18 EEE LEDs Enable Register**

Address	Name	Description	Mode	Default
18:15~3	Reserved	Reserved.	-	-
18:2	EEE_LED_en2	Enable LED2 in EEE/LPI Mode.	RW	0
18:1	EEE_LED_en1	Enable LED1 in EEE/LPI Mode.	RW	0
18:0	EEE_LED_en0	Enable LED0 in EEE/LPI Mode.	RW	0

## 7.19. Page7 Register 19 Interrupt, WOL Enable, and LEDs Function Registers

**Table 30. Page7 Register 19 Interrupt, WOL Enable, and LEDs Function Registers**

Address	Name	Description	Mode	Default																				
19:15~14	Reserved	Reserved.	-	-																				
19:13	Int_linkchg	Link Change Interrupt Mask. 1: Interrupt pin Enable 0: Interrupt pin Disable This bit set to 0 only masks the link change interrupt event in the INTB pin. Reg30 Bit11 always reflects the link change interrupt behavior (see Table 22, page 21).	RW	0																				
19:12	Int_dupchg	Duplex Change Interrupt Mask. 1: Interrupt pin Enable 0: Interrupt pin Disable This bit set to 0 only masks the duplex change interrupt event in the INTB pin. Reg30 Bit13 always reflects the duplex change interrupt behavior (see Table 22, page 21).	RW	0																				
19:11	Int_anerr	NWay Error Interrupt Mask. 1: Interrupt pin Enable 0: Interrupt pin Disable This bit set to 0 only masks the NWay Error interrupt event in the INTB pin. Reg30 Bit15 always reflects the NWay Error interrupt behavior (see Table 22, page 21).	RW	0																				
19:10	Rg_led0_wol_sel	LED and Wake-On-LAN Function Selection (RTL8201F Only). 1: Wake-On-LAN Function Enable 0: LED Function Enable An internal weakly pulled low resistor sets RXD[1] to the LED function (default). Use an external 4.7K $\Omega$ pulled high resistor to enable the WOL function for the RTL8201F.	RW/LI	0																				
19:9~6	Reserved	Reserved.	-	-																				
19:5~4	LED_sel[1:0]	Traditional LED Function Selection. <table border="1"> <thead> <tr> <th>LED_sel</th><th>00</th><th>01</th><th>10</th><th>11</th></tr> </thead> <tbody> <tr> <td>LED0</td><td>ACT<sub>ALL</sub></td><td>Link<sub>ALL</sub>/ ACT<sub>ALL</sub></td><td>Link<sub>10</sub>/ ACT<sub>ALL</sub></td><td>LINK<sub>10</sub>/ ACT<sub>10</sub></td></tr> <tr> <td>LED1</td><td>LINK<sub>100</sub></td><td>LINK<sub>100</sub></td><td>LINK<sub>100</sub></td><td>LINK<sub>100</sub>/ ACT<sub>100</sub></td></tr> <tr> <td>LED2</td><td>Reserved</td><td>Reserved</td><td>Reserved</td><td>Reserved</td></tr> </tbody> </table>	LED_sel	00	01	10	11	LED0	ACT <sub>ALL</sub>	Link <sub>ALL</sub> / ACT <sub>ALL</sub>	Link <sub>10</sub> / ACT <sub>ALL</sub>	LINK <sub>10</sub> / ACT <sub>10</sub>	LED1	LINK <sub>100</sub>	LINK <sub>100</sub>	LINK <sub>100</sub>	LINK <sub>100</sub> / ACT <sub>100</sub>	LED2	Reserved	Reserved	Reserved	Reserved	RW/ EFUS	11
LED_sel	00	01	10	11																				
LED0	ACT <sub>ALL</sub>	Link <sub>ALL</sub> / ACT <sub>ALL</sub>	Link <sub>10</sub> / ACT <sub>ALL</sub>	LINK <sub>10</sub> / ACT <sub>10</sub>																				
LED1	LINK <sub>100</sub>	LINK <sub>100</sub>	LINK <sub>100</sub>	LINK <sub>100</sub> / ACT <sub>100</sub>																				
LED2	Reserved	Reserved	Reserved	Reserved																				
19:3	Customized_LED	Customized LED Enable. 1: Customized LED function enable 0: Customized LED function disable See the section 8.4.7 Customized LED, page 35 for detail.	RW/ EFUS	0																				
19:2~1	Reserved	Reserved.	-	-																				
19:0	En10mlpi	Enable 10M LPI LED Function.	RW	0																				

## 7.20. Page7 Register 20 MII TX Isolate Register

**Table 31. Page7 Register 20 MII TX Isolate Register**

Address	Name	Description	Mode	Default
20:15	Rg_tx_isolate_en	Isolate MII TX Path Signals when TX Idle.	RW	0
20:14~0	Reserved	Reserved.	-	-

## 7.21. Page7 Register 24 Spread Spectrum Clock Register

**Table 32. Page7 Register 24 Spread Spectrum Clock Register**

Address	Name	Description	Mode	Default
24:15~1	Reserved	Reserved.	-	-
24:0	Rg_dis_ssc	0: SSC function is enabled 1: SSC function is disabled	RW	0

## 7.22. MMD Register Mapping and Definition

Note: MMD registers are placed at Page0 Register 13 and Register 14.

**Table 33. MMD Register Mapping and Definition**

Device	Offset	Access	Name	Description
3	0	RW	EEEPC1R	EEE PCS Control 1 Register
3	1	RO/RO, LH	EEEPS1R	EEE PCS Status Control 1 Register
3	20	RO	EEECR	EEE Capability Register
3	22	RC	EEEWER	EEE Wake Error Register
7	60	RW	EEEAR	EEE Advertisement Register
7	61	RO	EEELPAR	EEE Link Partner Ability Register

### 7.22.1. EEEPC1R (PCS Control 1 Register, MMD Device 3, Address 0x00)

**Table 34. EEEPC1R (PCS Control 1 Register, MMD Device 3, Address 0x00)**

Bit	Name	RW	Default	Description
3.0.15:11	RSVD	RW	0	Reserved.
3.0.10	Clock Stop Enable	RW	0	1: PHY stops RXC in LPI 0: RXC not stoppable
3.0.9:0	RSVD	RW	0	Reserved.

### 7.22.2. EEPS1R (PCS Status 1 Register, MMD Device 3, Address 0x01)

**Table 35. EEPS1R (PCS Status 1 Register, MMD Device 3, Address 0x01)**

Bit	Name	RW	Default	Description
3.1.15:12	RSVD	RO	0	Reserved.
3.1.11	TX LPI Received	RO, LH	0	1: TX PCS has received LPI 0: LPI not received
3.1.10	RX LPI Received	RO, LH	0	1: RX PCS has received LPI 0: LPI not received
3.1.9	TX LPI Indication	RO	0	1: TX PCS is currently receiving LPI 0: TX PCS is not currently receiving LPI
3.1.8	RX LPI Indication	RO	0	1: RX PCS is currently receiving LPI 0: RX PCS is not currently receiving LPI
3.1.7	RSVD	RO	0	Reserved.
3.1.6	Clock Stop Capable	RO	1	1: MAC stops TxC in LPI 0: TxC not stoppable
3.1.5:0	RSVD	RO	0	Reserved.

### 7.22.3. EECCR (EEE Capability Register, MMD Device 3; Address 0x14)

**Table 36. EECCR (EEE Capability Register, MMD Device 3; Address 0x14)**

Bit	Name	RW	Default	Description
3.20.15:2	RSVD	RO	0	Reserved.
3.20.1	100Base-TX EEE	RO	1	1: EEE is supported for 100Base-TX EEE 0: EEE is not supported for 100Base-TX EEE
3.20.0	RSVD	RO	1	Reserved.

### 7.22.4. EEWER (EEE Wake Error Register, MMD Device 3; Address 0x16)

**Table 37. EEWER (EEE Wake Error Register, MMD Device 3; Address 0x16)**

Bit	Name	RW	Default	Description
3.22.15:0	EEE Wake Error Counter	RC	0	Used by PHY types that support EEE to count wake time faults where the PHY fails to complete its normal wake sequence within the time required for the specific PHY type.

### 7.22.5. EEER (EEE Advertisement Register, MMD Device 7; Address 0x3c)

**Table 38. EEER (EEE Advertisement Register, MMD Device 7; Address 0x3c)**

Bit	Name	RW	Default	Description
7.60.15:3	RSVD	RW	0	Reserved.
7.60.1	100Base-TX EEE	RW	1	Advertise 100Base-TX EEE Capability. 1: Advertise 0: Do not advertise
7.60.0	RSVD	RW	0	Reserved.

### 7.22.6. EEELPAR (EEE Link Partner Ability Register, MMD Device 7; Address 0x3d)

**Table 39. EEELPAR (EEE Link Partner Ability Register, MMD Device 7; Address 0x3d)**

Bit	Name	RW	Default	Description
7.61.15:3	RSVD	RO	0	Reserved.
7.61.1	LP 100Base-TX EEE	RO	0	1: Link Partner is capable of 100Base-TX EEE 0: Link Partner is not capable of 100Base-TX EEE
7.61.0	RSVD	RO	0	Reserved.

## 8. Functional Description

The RTL8201F/FL/FN PHYceiver is a physical layer device that integrates 10Base-T and 100Base-TX/100Base-FX functions, and some extra power management features. This device supports the following functions:

- MII interface with MDC/MDIO management interface to communicate with the MAC
- IEEE 802.3u clause 28 Auto-Negotiation ability
- Speed, duplex, auto-negotiation ability configurable by hard wire or MDC/MDIO
- Power Down mode support
- 4B/5B transform
- Scrambling/De-scrambling
- NRZ to NRZI, NRZI to MLT-3
- Manchester Encode and Decode for 10Base-T operation
- Clock and Data recovery
- Adaptive Equalization
- Automatic Polarity Correction
- Far End Fault Indication (FEFI) in fiber mode
- Network status LEDs
- Wake-On-LAN (WOL)
- Energy Efficient Ethernet (EEE)
- Spread Spectrum Clock (SSC) for RMII REF\_CLK output mode



## 8.1. MII and Management Interface

### 8.1.1. Data Transition

The MII (Media Independent Interface) is an 18-signal interface (as described in IEEE 802.3u) supplying a standard interface between the PHY and MAC layer.

This interface operates at two frequencies; 25MHz and 2.5MHz, to support 100Mbps/10Mbps bandwidth for both transmit and receive functions.

#### Transmission

The MAC asserts the TXEN signal. It then changes byte data into 4-bit nibbles and passes them to the PHY via TXD[3:0]. The PHY will sample TXD[3:0] synchronously with TXC – the transmit clock signal supplied by the PHY – during the interval TXEN is asserted.

#### Reception

The PHY asserts the RXDV signal. It passes the received nibble data RXD[3:0] clocked by RXC. CRS and COL signals are used for collision detection and handling.

In 100Base-TX mode, when the decoded signal in 5B is not IDLE, the CRS signal will assert. When 5B is recognized as IDLE it will be de-asserted. In 10Base-T mode, CRS will assert when the 10M preamble has been confirmed and will be de-asserted when the IDLE pattern has been confirmed.

The RXDV signal will be asserted when decoded 5B are /J/K/ and will be de-asserted if the 5B are /T/R/ or IDLE in 100Mbps mode. In 10Mbps mode, the RXDV signal is the same as the CRS signal.

The RXER (Receive Error) signal will be asserted if any 5B decode errors occur, e.g., an invalid J/K, invalid T/R, or invalid symbol. This pin will go high for one or more clock periods to indicate to the reconciliation sublayer that an error was detected somewhere in the frame.

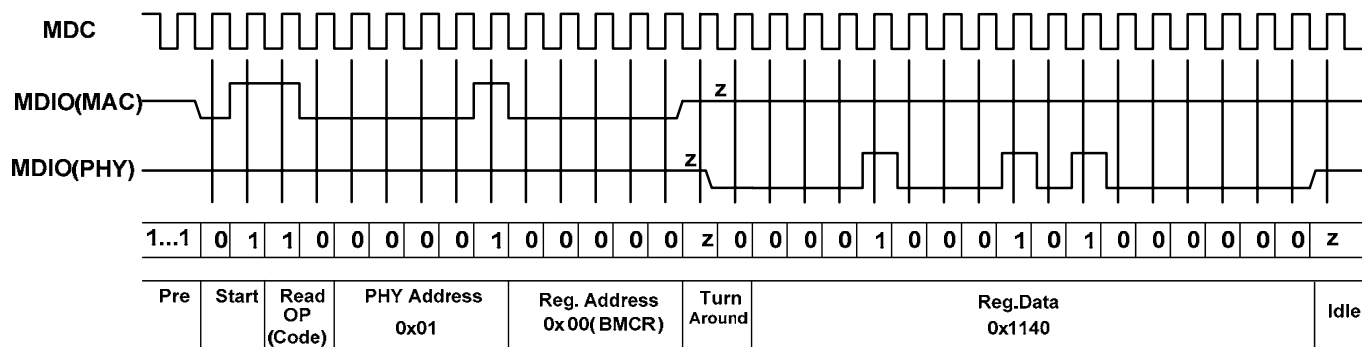
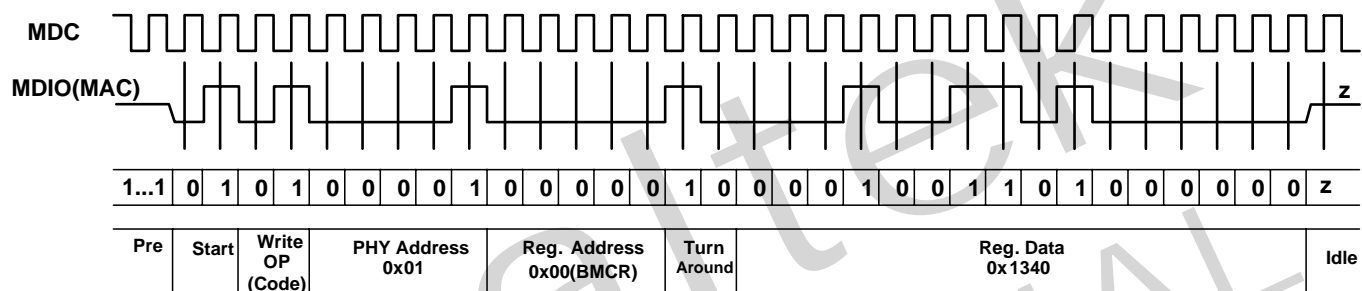
### 8.1.2. Serial Management Interface

The MAC layer device can use the MDC/MDIO management interface to control a maximum of 4 (RTL8201F/FL) or 8 (RTL8201FN) devices, configured with different PHY addresses (00b to 11b for the RTL8201F/FL; 000b to 111b for the RTL8201FN). Frames transmitted on the MDC/MDIO Management Interface should have the frame structure shown in Table 40.

**Table 40. Management Frame Format**

	Management Frame Fields							
	Preamble	ST	OP	PHYAD	REGAD	TA	DATA	IDLE
Read	1...1	01	10	AAAAA	RRRRR	Z0	DDDDDDDDDDDDDDDDDD	Z
Write	1...1	01	01	AAAAA	RRRRR	10	DDDDDDDDDDDDDDDDDD	Z

During a hardware reset, the logic levels of pins 34/24, 35/25, and 32/22 (only RTL8201FN) are latched to be set as the PHY address for management communication via the serial interface. The read and write frame structure for the management interface is illustrated in Figure 6 and Figure 7, page 30.


**Figure 6. Read Cycle**

**Figure 7. Write Cycle**
**Table 41. Serial Management**

Name	Description
Preamble	32 Contiguous Logical 1's Sent by the MAC on MDIO, along with 32 Corresponding Cycles on MDC. This provides synchronization for the PHY.
ST	Start of Frame. Indicated by a 01 pattern.
OP	Operation Code. Read: 10 Write: 01
PHYAD	PHY Address. Up to 4 PHYs can be connected to one MAC. This 2-bit field selects which PHY the frame is directed to.
REGAD	Register Address. This is a 5-bit field that sets which of the 32 registers of the PHY this operation refers to.
TA	Turnaround. This is a 2-bit-time spacing between the register address and the data field of a frame to avoid contention during a read transaction. For a read transaction, both the STA and the PHY remain in a high-impedance state for the first bit time of the turnaround. The PHY drives a zero bit during the second bit time of the turnaround of a read transaction.
DATA	Data. These are the 16 bits of data.
IDLE	Idle Condition. Not truly part of the management frame. This is a high impedance state. Electrically, the PHY's pull-up resistor will pull the MDIO line to a logical '1'.

## 8.2. Interrupt

Whenever there is a status change on the media detected by the RTL8201F/FL/FN, they will drive the interrupt pin (INTB) low to issue an interrupt event. The MAC senses the status change and accesses the page0 register30 through the MDC/MDIO interface in response.

Once these status registers page0 register30 have been read by the MAC through the MDC/MDIO, the INTB is de-asserted. The RTL8201FN/FL interrupt function removes the need for continuous polling through the MDC/MDIO management interface.

*Note 1: The RTL8201F RXD[2]/INTB pin (Pin11) is used for the interrupt function only when in the RMII mode.*

*Note 2: The Interrupt function is disabled by default. To enable this function, refer to Table 30, page 24 (Page7 Register 19 Bit[13:11]).*

## 8.3. Auto-Negotiation and Parallel Detection

The RTL8201F/FL/FN supports IEEE 802.3u clause 28 Auto-negotiation for operation with other transceivers supporting auto-negotiation. The RTL8201F/FL/FN can auto-detect the link partner's abilities and determine the highest speed/duplex configuration possible between the two devices. If the link partner does not support auto-negotiation, then the RTL8201F/FL/FN will enable half-duplex mode and enter parallel detection mode. The RTL8201F/FL/FN will default to transmitting FLP (Fast Link Pulse) and wait for the link partner to respond. If the RTL8201F/FL/FN receives a FLP, then the auto-negotiation process will continue. If it receives an NLP (Normal Link Pulse), then the RTL8201F/FL/FN will change to 10Mbps and half-duplex mode. If it receives a 100Mbps IDLE pattern, it will change to 100Mbps and half-duplex mode.

### 8.3.1. Setting the Medium Type and Interface Mode to MAC

**Table 42. Setting the Medium Type and Interface Mode to MAC**

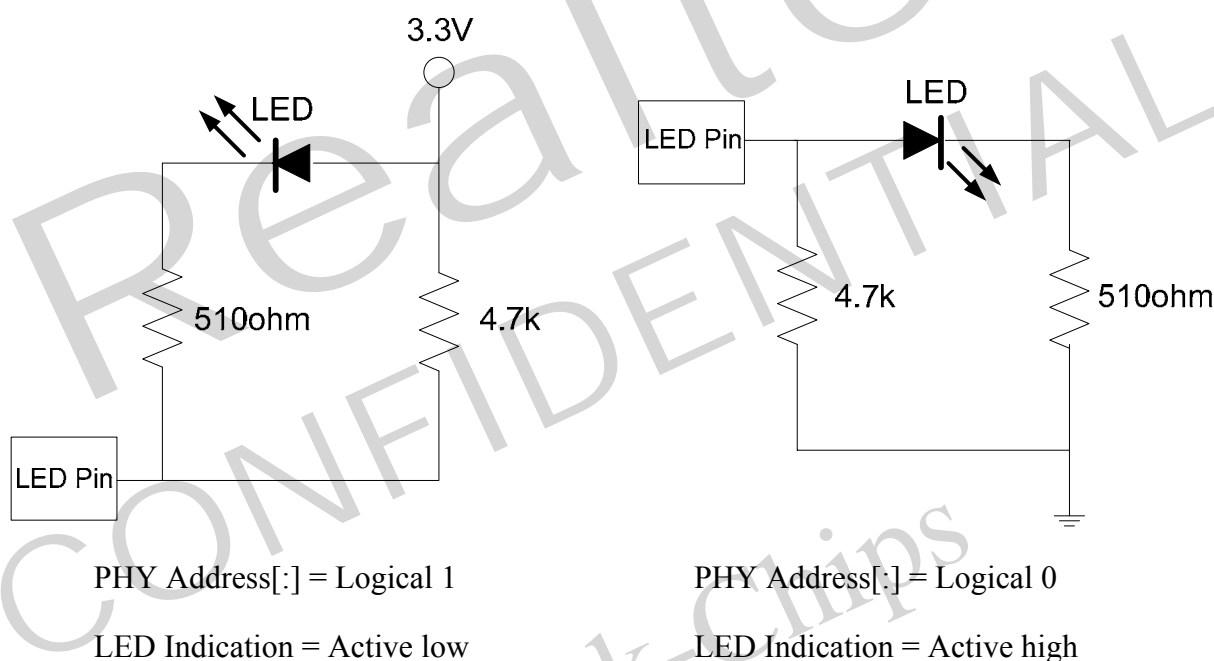
FXEN	RXDV	Operation Mode
H	L	Fiber Mode and MII Mode
H	H	Fiber Mode and RMII Mode
H	X	Fiber Mode and MII Mode
L	L	UTP Mode and MII Mode
L	H	UTP Mode and RMII Mode
L	X	UTP Mode and MII Mode

## 8.4. LED Functions

The RTL8201FN supports three LED signals, and the RTL8201F and RTL8201FL support two LED signals, in four configurable operation modes. The following sections describe the various LED actions.

### 8.4.1. LED and PHY Address

As the PHYAD strap options share the LED output pins, the external combinations required for strapping and LED usage must be considered in order to avoid contention. Specifically, when the LED outputs are used to drive LEDs directly, the active state of each output driver is dependent on the logic level sampled by the corresponding PHYAD input upon power-up/reset. For example, as Figure 8 (left-side) shows, if a given PHYAD input is resistively pulled high then the corresponding output will be configured as an active low driver. On the right side, we can see that if a given PHYAD input is resistively pulled low then the corresponding output will be configured as an active high driver. The PHY address configuration pins should not be connected to GND or VCC directly, but must be pulled high or low through a resistor (e.g., 4.7K $\Omega$ ). If no LED indications are needed, the components of the LED path (LED+510 $\Omega$ ) can be removed.



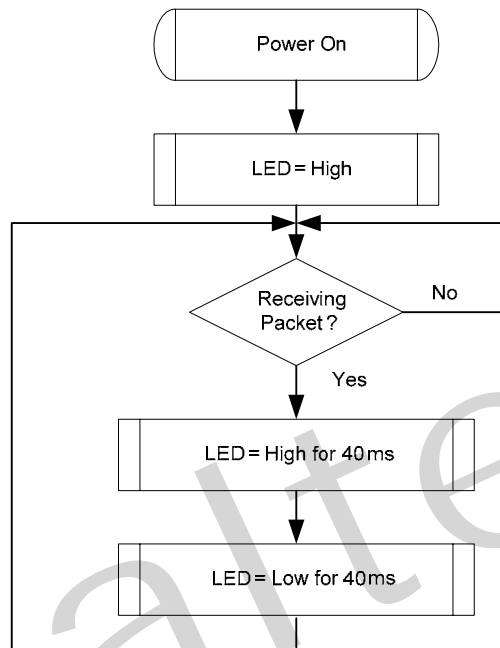
**Figure 8. LED and PHY Address Configuration**

### 8.4.2. Link Monitor

The Link Monitor senses link integrity, such as LINK<sub>10</sub>, LINK<sub>100</sub>, LINK<sub>10</sub>/ACT, or LINK<sub>100</sub>/ACT. Whenever link status is established, the specific link LED pin is driven low. Once a cable is disconnected, the link LED pin is driven high, indicating that no network connection exists.

### 8.4.3. RX LED

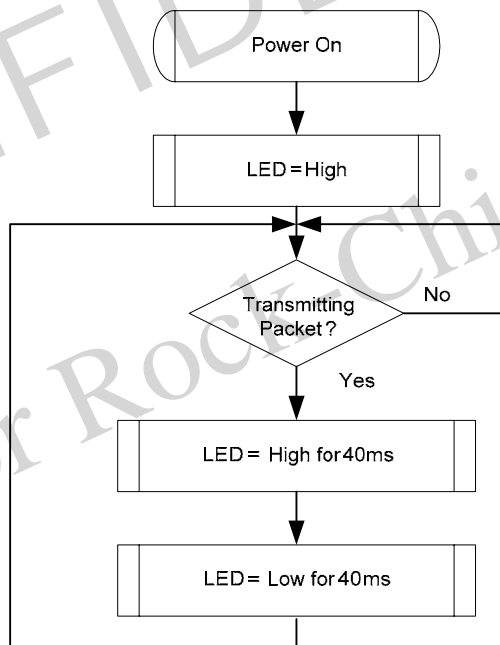
In 10/100M mode, blinking of the RX LED indicates that receive activity is occurring.



**Figure 9. RX LED**

### 8.4.4. TX LED

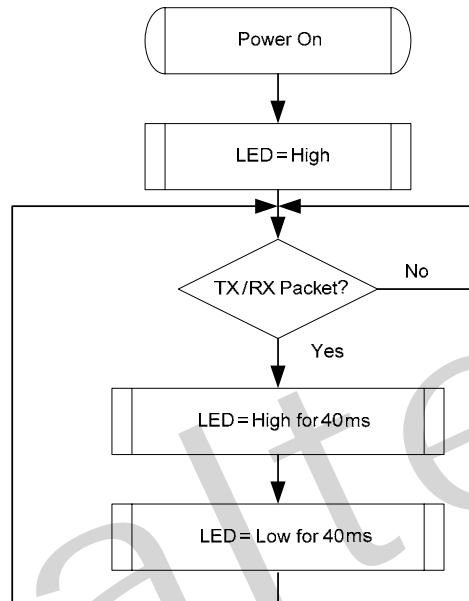
In 10/100M mode, blinking of the TX LED indicates that transmit activity is occurring.



**Figure 10. TX LED**

### 8.4.5. TX/RX LED

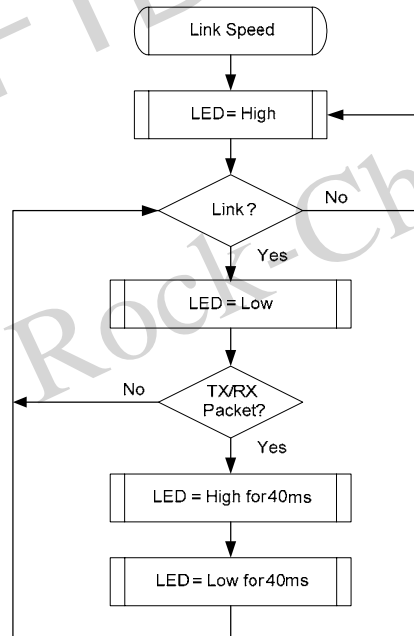
In 10/100M mode, blinking of the TX/RX LED indicates that both transmit and receive activity is occurring.



**Figure 11. TX/RX LED**

### 8.4.6. LINK/ACT LED

In 10/100M mode, blinking of the LINK/ACT LED indicates that the RTL8201F/FL/FN is linked and operating properly. When this LED is high for extended periods, it indicates that a link problem exists.

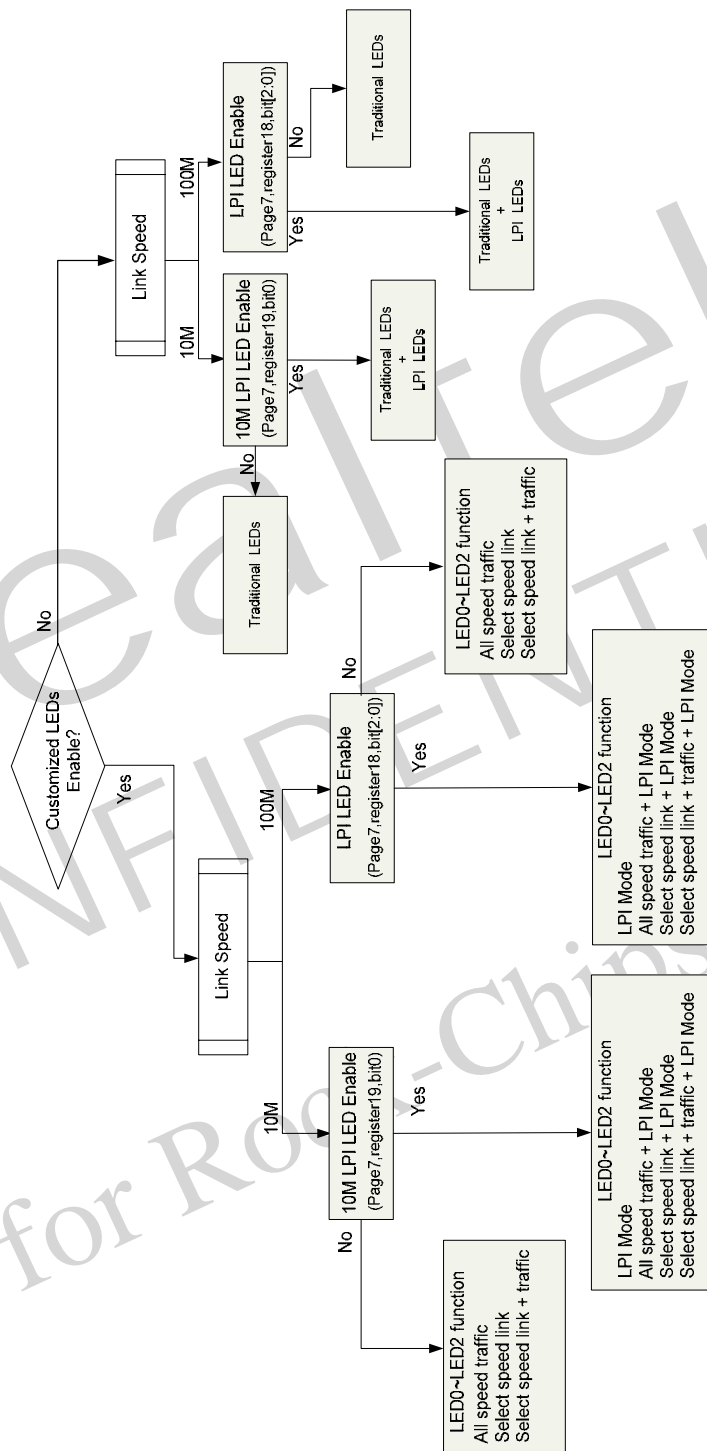


**Figure 12. LINK/ACT LED**

### 8.4.7. Customized LED

The RTL8201F/FL/FN supports programmable LEDs in 10/100Mbps mode. This function can be enabled/disabled via page7, reg19[3] register (Figure 13).

Refer to section 7.17, page 23 for customized LED register setting.



**Figure 13. Customized LED with/without LPI LED Mode**

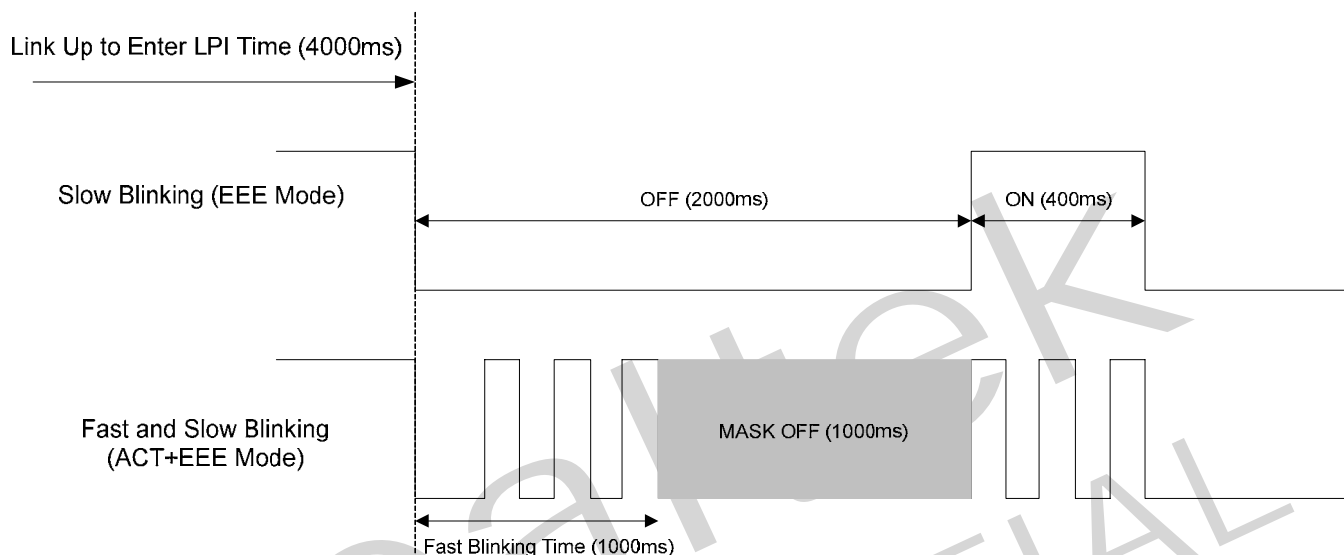


### 8.4.8. EEE LED Behavior

EEE Idle mode: LED continuous slow blinking.

EEE Active mode: LED fast and slow blinking (on packet transmission and reception).

Refer to Table 29, page 23 for EEE LED enable setting.



**Figure 14. EEE LED Behavior**

## 8.5. Power Down and Link Down Power Saving Modes

Two types of Power Saving mode operation are supported. This section describes how to implement each mode through software.

**Table 43. Power Saving Mode Pin Settings**

Mode	Description
PWD	Setting bit 11 of register 0 to 1 puts the RTL8201F/FL/FN into Power Down Mode (PWD). This is the maximum power saving mode while the RTL8201F/FL/FN is still 'live'. In PWD mode, the RTL8201F/FL/FN will turn off all analog/digital functions except the MDC/MDIO management interface. Therefore, if the RTL8201F/FL/FN is put into PWD mode and the MAC wants to recall the PHY, it must create the MDC/MDIO timing by itself (this is done by software).
LDPS	Setting bit 15 of register 24 to 1 will put the RTL8201F/FL/FN into LDPS (Link Down Power Saving) mode. In LDPS mode, the RTL8201F/FL/FN will detect the link status to decide whether or not to turn off the transmit function. If the link is off, FLP or 100Mbps IDLE/10Mbps NLP will not be transmitted. However, some signals similar to NLP will be transmitted. Once the receiver detects leveled signals, it will stop the signal and transmit FLP or 100Mbps IDLE/10Mbps NLP again. This can cut power used by 60%~80% when the link is down.

## **8.6. 10/100M Transmit and Receive**

### **8.6.1. 100Base-TX Transmit and Receive Operation**

#### **100Base-TX Transmit**

Transmit data in 4-bit nibbles (TXD[3:0]) clocked at 25MHz (TxC) is transformed into 5B symbol code (4B/5B encoding). Scrambling, serializing, and conversion to 125MHz, and NRZ to NRZI then takes place. The NRZI signal is passed to the MLT-3 encoder, then to the transmit line driver. The transmitter will first assert TXEN. Before transmitting the data pattern, it will send a /J/K/ symbol (Start-of-frame delimiter), the data symbol, and finally a /T/R/ symbol known as the End-Of-Frame delimiter. For better EMI performance, the seed of the scrambler is based on the PHY address. In a hub/switch environment, each RTL8201F/FL/FN will have different scrambler seeds and so spread the output of the MLT-3 signals.

#### **100Base-TX Receive**

The received signal is compensated by the adaptive equalizer to make up for signal loss due to cable attenuation and Inter Symbol Interference (ISI). Baseline Wander Correction monitors the process and dynamically applies corrections to the process of signal equalization. The Phase Locked Loop (PLL) then recovers the timing information from the signals and from the receive clock. With this, the received signal is sampled to form NRZI (Non-Return-to-Zero Inverted) data. The next steps are the NRZI to NRZ (Non-Return-to-Zero) process, unscrambling of the data, serial to parallel and 5B to 4B conversion, and passing of the 4B nibble to the MII interface.

### **8.6.2. 100Base-FX Fiber Transmit and Receive Operation**

The RTL8201F/FL/FN can be configured to 100Base-FX mode via hardware configuration. The hardware 100Base-FX setting takes priority over NWay settings. A scrambler is not required in 100Base-FX.

#### **100Base-FX Transmit**

Di-bits of TXD are processed as 100Base-TX except without a scrambler before the NRZI stage. Instead of converting to MLT-3 signals, as in 100Base-TX, the serial data stream is driven out as NRZI PECL signals, which enter the fiber transceiver in differential-pair form.

#### **100Base-FX Receive**

The signal is received through PECL receiver inputs from the fiber transceiver and directly passed to the clock recovery circuit for data/clock recovery. The scrambler/de-scrambler is bypassed in 100Base-FX.

### **8.6.3. 10Base-T Transmit and Receive Operation**

#### **10Base-T Transmit**

Transmit data in 4-bit nibbles (TXD[3:0]) clocked at 2.5MHz (TxC) is first fed to a parallel-to-serial converter, then the 10Mbps NRZ signal is sent to a Manchester encoder. The Manchester encoder converts the 10Mbps NRZ data into a Manchester Encoded data stream for the TP transmitter and adds a Start of Idle pulse (SOI) at the end of the packet as specified in IEEE 802.3. Finally, the encoded data stream is shaped by a band-limited filter embedded in the RTL8201F/FL/FN and then transmitted.

## 10Base-T Receive

In 10Base-T receive mode, the Manchester decoder in the RTL8201F/FL/FN converts the Manchester encoded data stream into NRZ data by decoding the data and stripping off the SOI pulse. The serial NRZ data stream is then converted to a parallel 4-bit nibble signal (RXD[0:3]).

## 8.7. Reset and Transmit Bias

There are two RTL8201F/FL/FN reset types:

1. Hardware Reset: Pull the PHYRSTB pin high for at least 150ms to access the RTL8201F/FL/FN registers. Pull the PHYRSTB pin low for at least 10ms and then pull high. All registers will return to default values after a hardware reset. The media interface will disconnect and restart the auto-negotiation/parallel detection process.
2. Software Reset: Set register 0 bit 15 to 1 for at least 20ms to access the RTL8201F/FL/FN registers. A Software reset will only partially reset the registers, and will reset the chip status to 'initializing'.

The RSET pin must be pulled low by a 2.49K $\Omega$  resistor with 1% accuracy to establish an accurate transmit bias. This will affect the signal quality of the transmit waveform. Keep its circuitry away from other clock traces and transmit/receive paths to avoid signal interference.

## 8.8. 3.3V Power Supply and Voltage Conversion Circuit

The RTL8201F/FL/FN is fabricated in a 0.11 $\mu$ m process. The core circuit needs to be powered by 1.1V, however, the digital IO and DAC circuits need a 3.3V power supply. Regulators are embedded in the RTL8201F/FL/FN to convert 3.3V to 1.1V.

*Note: The internal linear regulator output voltage is 1.1V.*

*1.05V is supplied when using external core power. An external 1.05V power supply is not suggested for the RTL8201F/FL as the internal regulators cannot be disabled (the RTL8201F/FL does not have an EN\_LDO\_OUT pin to disable the internal 1.1V power supply), and the internal and external power sources may conflict.*

As with many commercial voltage conversion devices, the 1.1V output pin of this circuit requires the use of an output capacitor (0.1 $\mu$ F X5R low-ESR ceramic capacitor) as part of the device frequency compensation.

The analog and digital ground planes should be as large and intact as possible. If the ground plane is large enough, the analog and digital grounds can be separated, which is the ideal configuration. However, if the total ground plane is not sufficiently large, partition of the ground plane is not a good idea. In this case, all the ground pins can be connected together to a larger single and intact ground plane.

*Note: The embedded 1.1V LDO is designed for PHYceiver device internal use only. Do not provide this power to other devices.*

## **8.9. Automatic Polarity Correction**

The RTL8201F/FL/FN automatically corrects polarity errors on the receive pairs in 10Base-T mode (polarity is irrelevant in 100Base-TX mode). In 10Base-T mode, polarity errors are corrected based on the detection of validly spaced link pulses. Detection begins during the MDI crossover detection phase and locks when the 10Base-T link is up. The polarity becomes unlocked when the link goes down.

## **8.10. Far End Fault Indication**

The MII Reg.1.4 (Remote Fault) is the Far End Fault Indication (FEFI) bit when 100FX mode is enabled, and indicates when a FEFI has been detected. FEFI is an alternative in-band signaling method that is composed of 84 consecutive '1's followed by one '0'. When the RTL8201F/FL/FN detects this pattern three times, Reg.1.4 is set, which means the transmit path (the Remote side's receive path) has a problem. On the other hand, if an incoming signal fails to cause a 'Link OK', the RTL8201F/FL/FN will start sending this pattern, which in turn causes the remote side to detect a Far End Fault. This means that the receive path has a problem from the point of view of the RTL8201F/FL/FN. The FEFI mechanism is used only in 100Base-FX mode.

## **8.11. Wake-On-LAN (WOL)**

### **8.11.1. Magic Packet and Wake-Up Frame Format**

The RTL8201F/FL/FN can monitor the network for a Wake-Up Frame or a Magic Packet, and notify the system via the PMEB (Power Management Event; 'B' means low active) pin when such a packet or event occurs. The system can then be restored to a normal state to process incoming jobs. The PMEB pin must be connected with a 4.7k-ohm resistor and pulled up to 3.3V. When the Wake-Up Frame or a Magic Packet is sent to the PHY, the PMEB pin will be set low to notify the system to wake up. Refer to the WOL application note for details.

Magic Packet Wake-Up occurs only when the following conditions are met:

- The destination address of the received Magic Packet is acceptable to the RTL8201F/FL/FN, e.g., a broadcast, multicast, or unicast packet addressed to the current RTL8201F/FL/FN.
- The received Magic Packet does not contain a CRC error.
- The Magic Packet pattern matches; i.e.,  $6 * FFh + \text{MISC (can be none)} + 16 * \text{DID (Destination ID)}$  in any part of a valid Ethernet packet.

A Wake-Up Frame event occurs only when the following conditions are met:

- The destination address of the received Wake-Up Frame is acceptable to the RTL8201F/FL/FN, e.g., a broadcast, multicast, or unicast address to the current RTL8201F/FL/FN.
- The received Wake-Up Frame does not contain a CRC error.

- The 16-bit CRC of the received Wake-Up Frame matches the 16-bit CRC of the sample Wake-Up Frame pattern given by the local machine's OS. Or, the RTL8201F/FL/FN is configured to allow direct packet wake up, e.g., a broadcast, multicast, or unicast network packet.

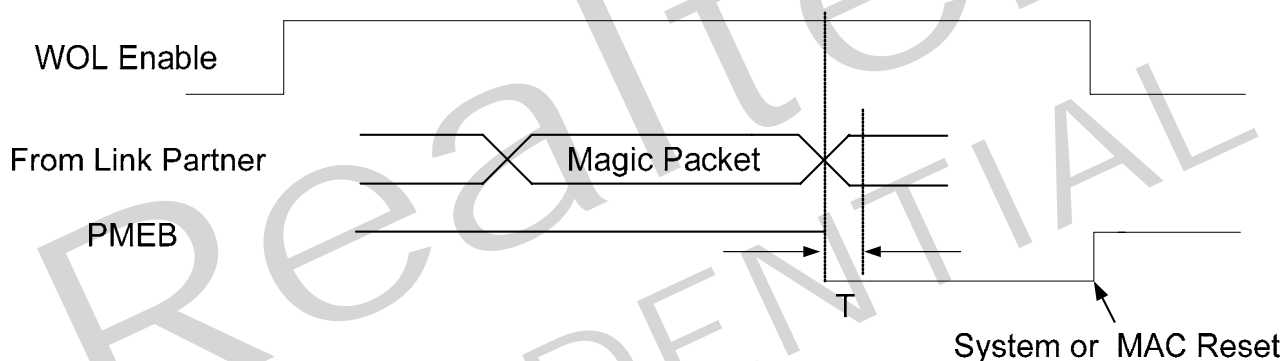
*Note 1: 16-bit CRC: The RTL8201F/FL/FN supports eight long-Wake-Up frames (covering 128 mask bytes from offset 0 to 127 of any incoming network packet). CRC16 polynomial= $x^{16}+x^{12}+x^5+1$ .*

*Note 2: Refer to the WOL Application Note for detailed Wake-On-LAN register settings and waveform timings.*

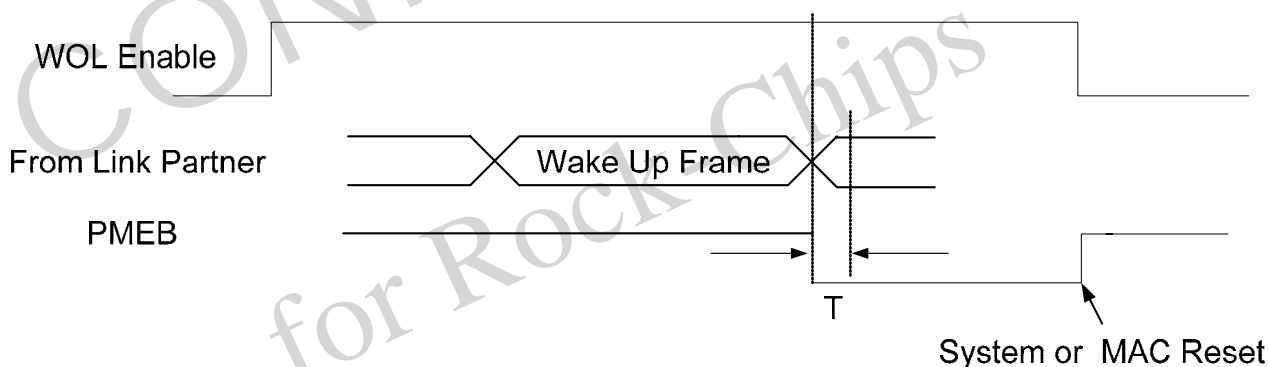
### 8.11.2. Active Low Wake-On-LAN

When the PHY receives a Wake-Up Frame or a Magic Packet from the link partner, the PMEB pin will go low and the MAC will wake up after a T cycle. The PMEB pin will be reset to high via the system or MAC Reset.

Refer to the WOL Application Note for details.



**Figure 15. Active Low When Receiving a Magic Packet**

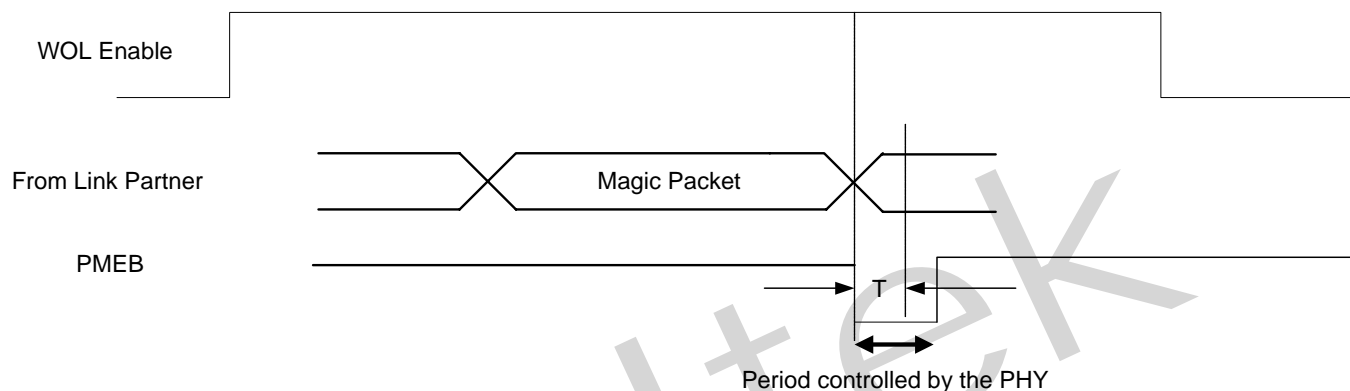


**Figure 16. Active Low When Receiving a Wake-Up Frame**

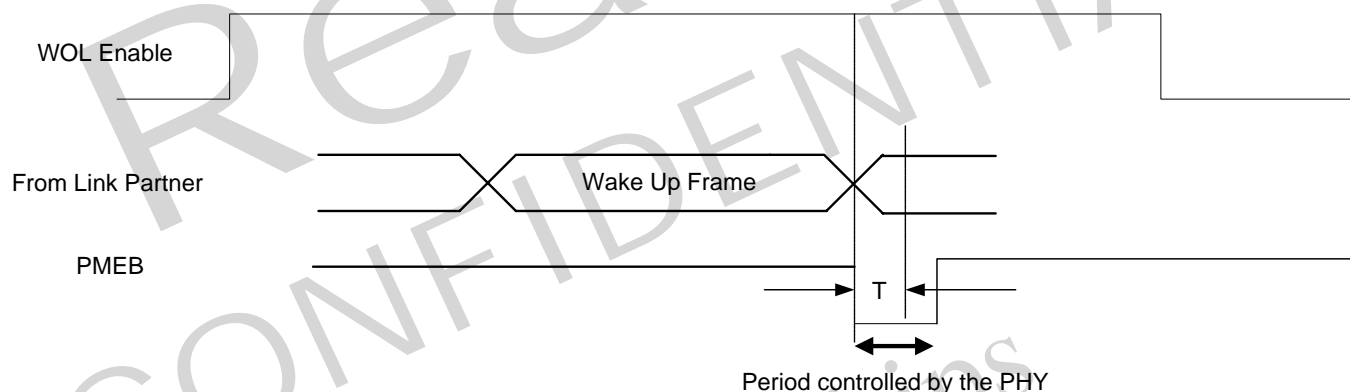
### 8.11.3. Pulse Low Wake-On-LAN

When the PHY receives a Wake-Up Frame or a Magic Packet from the link partner, the PMEB pin will go low for a period (84ms, 168ms (default), 336ms, or 672ms; set through the MDC/MDIO), and will wake up after a T cycle (Figure 17 and Figure 18).

Refer to the WOL Application Note for details.



**Figure 17. Pulse Low When Receiving a Magic Packet**



**Figure 18. Pulse Low When Receiving a Wake-Up Frame**

### 8.11.4. Wake-On-LAN Pin Types (MII Mode)

**Table 44. Wake-On-LAN Pin Types (MII Mode)**

Name	Type	Normal			WOL Enable
		100M	10M	Idle	
TXC	O/PD	25M CLK Output	2.5M CLK Output	2.5M CLK Output	O (2.5M/25M)/L/PD <sup>1</sup>
TXEN	I/PD	I	I	I	I/PD
TXD[0:3]	I/PD	I	I	I	I/PD
RXC	O/PD	25M CLK Output	2.5M CLK Output	2.5M CLK Output	O (2.5M/25M)/PD <sup>2</sup>
COL	LI/O/PD	O	O	O	O or PD <sup>2</sup>
CRS	LI/O/PD	O	O	O	O or PD <sup>2</sup>
RXDV	LI/O/PD	O	O	O	O or PD <sup>2</sup>
RXD[0:2]	O/PD	O	O	O	O or PD <sup>2</sup>
RXD[3]	LI/O/PD	O	O	O	O or PD <sup>2</sup>
RXER	LI/O/PD	O	O	O	O or PD <sup>2</sup>
MDC	I/PU	I	I	I	I/PU
MDIO	IO/PU	IO	IO	IO	IO/PU

Note 1: If TX Isolate=1, the TXC is halted and the pin type is 'L'.

Set page0, register0, and bit10=1 to change the TXC pin type to 'PD'.

Note 2: If RX Isolate=1, all the MII RX interfaces are halted and the pin types are 'PD'.

### 8.11.5. Wake-On-LAN Pin Types (RMII Mode)

**Table 45. Wake-On-LAN Pin Types (RMII Mode)**

Name	Type	Normal			WOL Enable
		100M	10M	Idle	
TXC (REF_CLK) <sup>1</sup>	IO/PD	50M CLK Input/Output	50M CLK Input/Output	50M CLK Input/Output	I/O (50M) <sup>2</sup>
TXEN	I/PD	I	I	I	I/PD
TXD[0:1]	I/PD	I	I	I	I/PD
CRS_DV	LI/O/PD	O	O	O	O or PD <sup>3</sup>
RXD[0:1]	O/PD	O	O	O	O or PD <sup>3</sup>
RXER	LI/O/PD	O	O	O	O or PD <sup>3</sup>
MDC	I/PU	I	I	I	I/PU
MDIO	IO/PU	IO	IO	IO	IO/PU

Note 1: If TXC (REF\_CLK) is in input mode (MAC to PHY), the REF\_CLK cannot halt at WOL Enable.

Note 2: When REF\_CLK is in output mode (PHY to MAC), the REF\_CLK cannot halt (always toggles 50MHz out). To set the TXC pin type to 'PD', set page0, register0, bit10=1.

Note 3: If RX Isolate=1, all RMII RX interfaces are halted and the pin types are 'PD'.



## 8.12. Energy Efficient Ethernet (EEE)

The RTL8201F/FL/FN supports IEEE 802.3az-2010, also known as Energy Efficient Ethernet (EEE), at 10Mbps and 100Mbps. It provides a protocol to coordinate transitions to/from a lower power consumption level (Low Power Idle mode) based on link utilization. When no packets are being transmitted, the system goes to Low Power Idle mode to save power. When packets need to be transmitted, the system returns to normal mode, and does this without changing the link status and without dropping/corrupting frames.

To save power, when the system is in Low Power Idle mode, most of the circuits are disabled; however, the transition time to/from Low Power Idle mode is kept small enough to be transparent to upper layer protocols and applications.

EEE also specifies a negotiation method to enable link partners to determine whether EEE is supported.

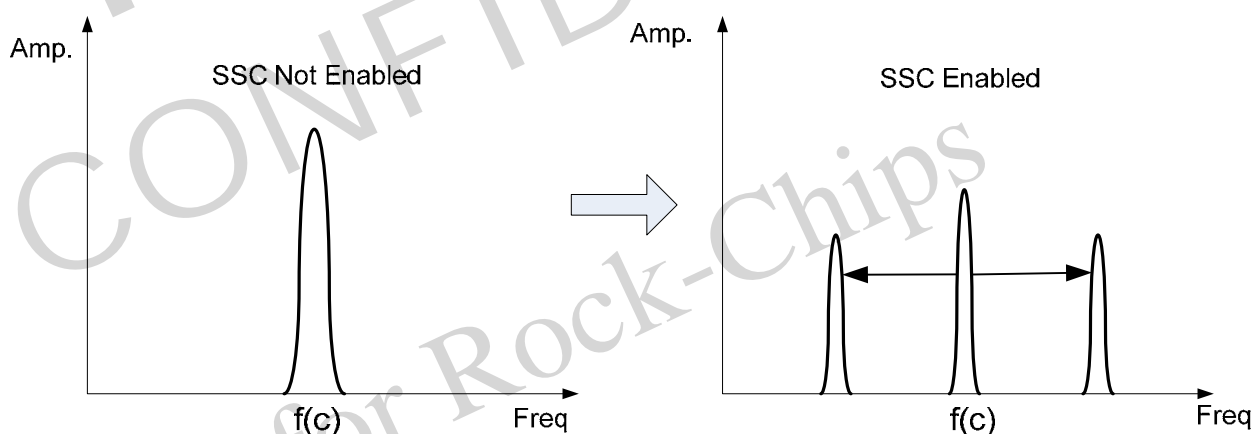
Refer to <http://www.ieee802.org/3/az/index.html> for more details.

Refer to the 'RTL8201(F\_FL\_FN)\_(R)MII\_Behavior\_in\_EEE\_App\_Note' for EEE MII/RMII power saving mode register settings.

## 8.13. Spread Spectrum Clock (SSC)

The RMII REF\_CLK path can be a source of EMI noise. Spread Spectrum Clock (SSC) spreads the REF\_CLK signal across a wider bandwidth, reducing the peak radiated energy at any one frequency, and lowering unwanted EMI noise.

The SSC function is enabled by default when using RMII REF\_CLK output mode (see section 7.21 Page7 Register 24 Spread Spectrum Clock Register, page 25).



**Figure 19. Spectrum Spread Clock**

## 9. Characteristics

### 9.1. DC Characteristics

#### 9.1.1. Absolute Maximum Ratings

**Table 46. Absolute Maximum Ratings**

Symbol	Description	Minimum	Maximum	Unit
DVDD33, AVDD33	Supply Voltage 3.3V	-0.3	+3.7	V
DVDD10, DVDD10OUT, AVDD10OUT	Supply Voltage 1.05V*	-0.1	+1.26	V
DC Input	Input Voltage	-0.3	Corresponding Supply Voltage +0.5V	V
DC Output	Output Voltage	-0.3	Corresponding Supply Voltage +0.5V	V
N/A	Storage Temperature	-55	+125	°C

*Note: The internal linear regulator output voltage is 1.1V.*

#### 9.1.2. Recommended Operating Conditions

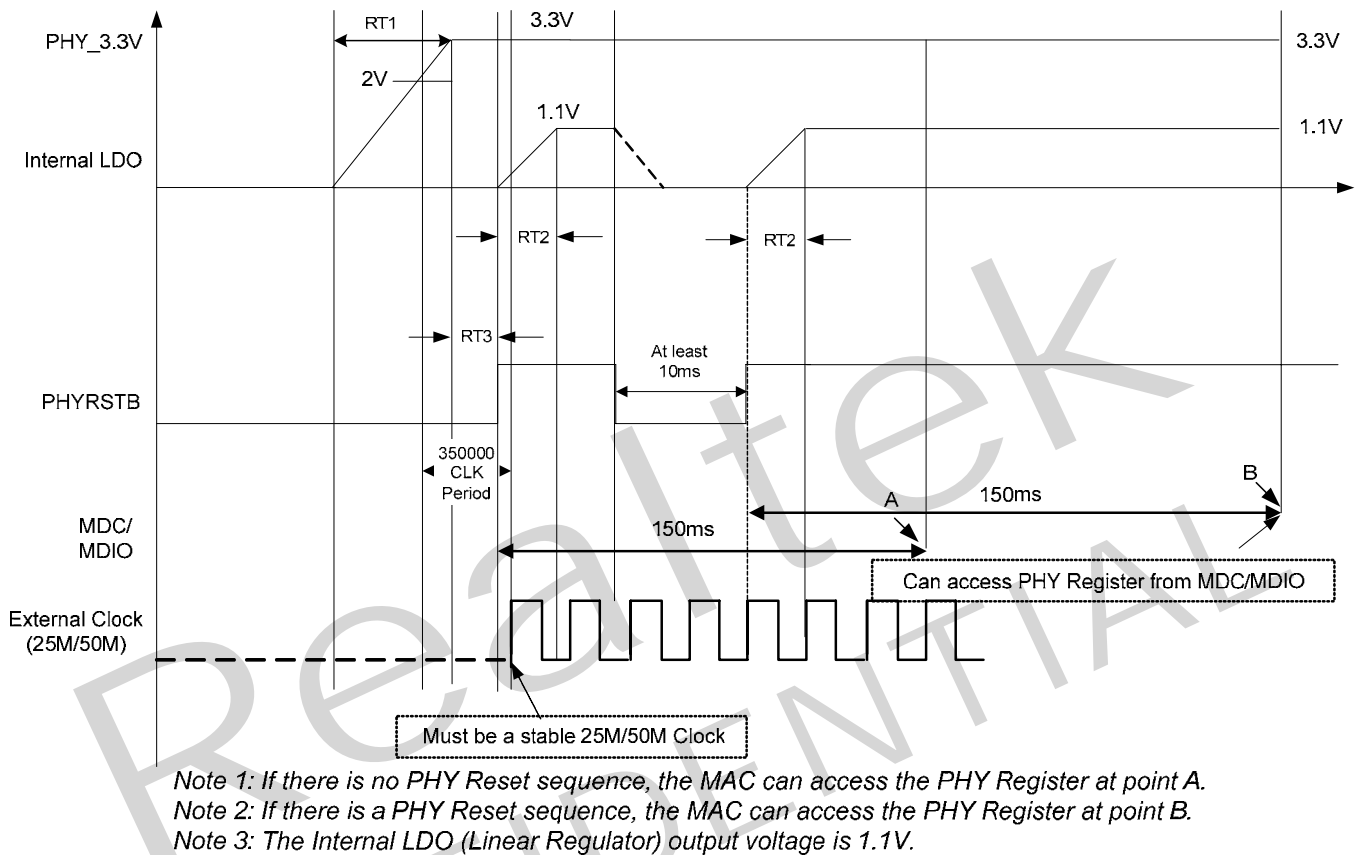
**Table 47. Recommended Operating Conditions**

Description	Pins	Minimum	Typical	Maximum	Unit
Supply Voltage VDD	DVDD33, AVDD33	2.97	3.30	3.63	V
	DVDD10, DVDD10OUT, AVDD10OUT	1.00	1.05*	1.16	V
Ambient Operating Temperature T <sub>A</sub>	-	0	-	70	°C
Maximum Junction Temperature	-	-	-	125	°C

*Note: The internal linear regulator output voltage is 1.1V.*

### 9.1.3. Power On and PHY Reset Sequence

The RTL8201F/FL/FN needs 150ms power on time. After 150ms it can access the PHY register from MDC/MDIO.



**Figure 20. Power On and PHY Reset Sequence**

**Table 48. Power On and PHY Reset Sequence**

Symbol	Description	Minimum	Maximum
Rt1	3.3V Rise Time@ Power On Sequence	100μs	-
Rt2	1.05V Rise Time@ Power On and PHY Reset Sequence	100μs	-
Rt3	PHYRSTB De-Assert after PHY_3.3V Stable	80μs	-

*Note: Rt2 requires 100μs Rise Time only when using an external 1.05V power supply.*

### 9.1.4. RMII Input Mode Power Dissipation

The whole system power dissipation (including regulator loss) is shown in Table 49.

**Table 49. RMII Input Mode Power Dissipation (Whole System)**

Symbol	Condition	RTL8201F	RTL8201FN	RTL8201FL	Unit
P <sub>10IDLE</sub>	10Base-T Idle (EEE not Enabled)	36.3	36.3	36.3	mW
P <sub>10F</sub>	10Base-T Full Duplex	108.9	118.8	108.9	mW
P <sub>100IDLE</sub>	100Base-T Idle (EEE not Enabled)	148.5	151.8	155.1	mW
P <sub>100IDLEEEE</sub>	100Base-T Idle with EEE	56.1	56.1	62.7	mW
P <sub>100F</sub>	100Base-T Full Duplex	174.9	178.2	178.2	mW
P <sub>LDPS</sub>	Link Down Power Saving	20.328	17.985	23.1	mW
P <sub>PHYRST</sub>	PHY Reset	3.3	3.3	3.3	mW

Note: Setting page4 register 21 bit12 to '1' will reduce power consumption when the system is idle.

### 9.1.5. Input Voltage: Vcc

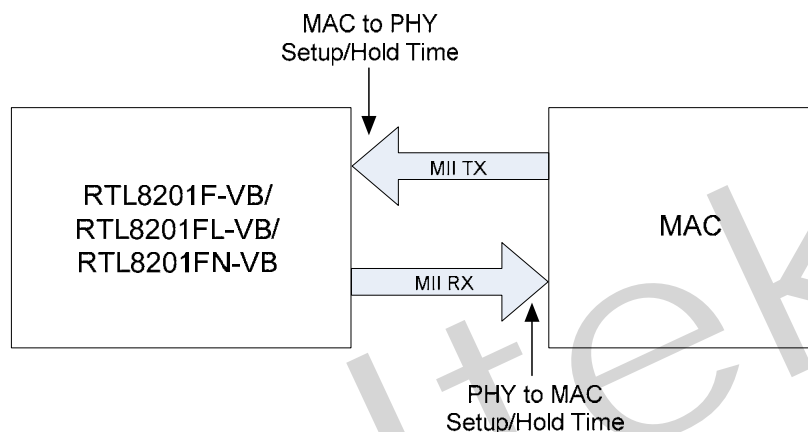
**Table 50. Input Voltage: Vcc**

Symbol	Condition	Minimum	Maximum
TTL V <sub>IH</sub>	Input High Voltage	2V	Vcc
TTL V <sub>IL</sub>	Input Low Voltage	-0.3V	0.7V
TTL V <sub>OH</sub>	Output High Voltage	IOH=-8mA	0.65*Vcc
TTL V <sub>OL</sub>	Output Low Voltage	IOL=8mA	0.7V
TTL I <sub>OZ</sub>	Tri-State Leakage	Vout=Vcc or GND	-110μA
I <sub>IN</sub>	Input Current	Vin=Vcc or GND	-1μA
I <sub>PL</sub>	Input Current with Internal Weakly Pulled Low Resistor	Vin=Vcc or GND	-1μA
I <sub>PH</sub>	Input Current with Internal Weakly Pulled High Resistor	Vin=Vcc or GND	-110μA
PECL V <sub>IH</sub>	PECL Input High Voltage	-	Vdd-1.16V
PECL V <sub>IL</sub>	PECL Input Low Voltage	-	Vdd-1.81V
PECL V <sub>OH</sub>	PECL Output High Voltage	-	Vdd-1.02V
PECL V <sub>OL</sub>	PECL Output Low Voltage	-	Vdd-1.62V

## 9.2. AC Characteristics

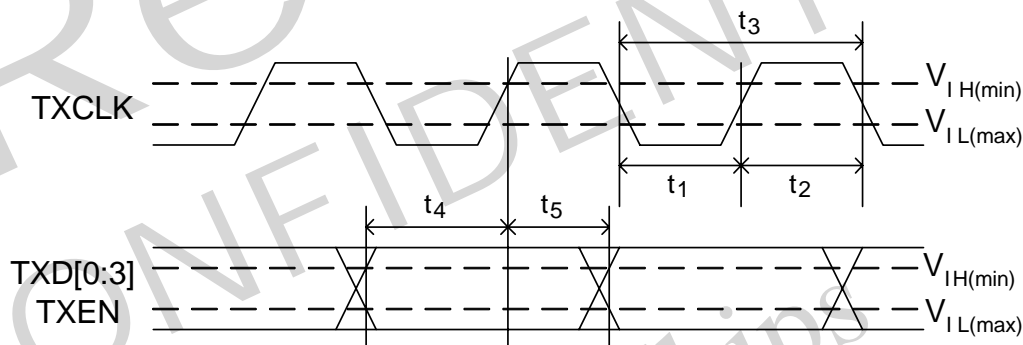
All output timing assumes equivalent loading between 10pF and 25pF that includes PCB layout traces and other connected devices (e.g., MAC).

### 9.2.1. MII Transmission Cycle Timing

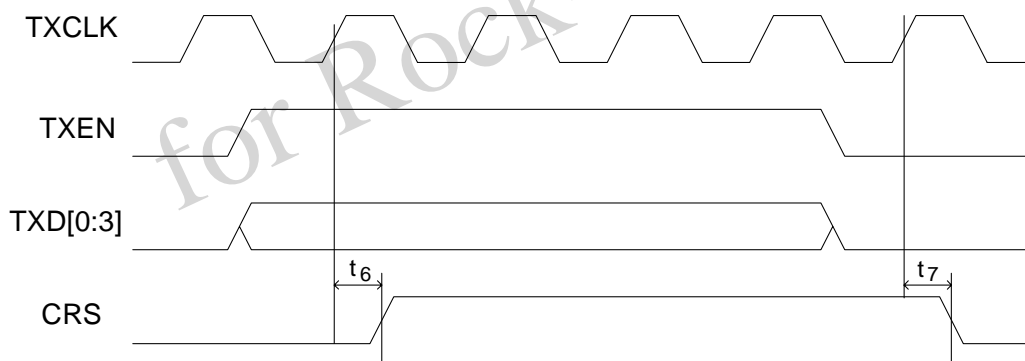


**Figure 21. MII Interface Setup/Hold Time Definitions**

Figure 22 and Figure 23 show an example of a packet transfer from MAC to PHY on the MII interface.



**Figure 22. MII Transmission Cycle Timing-1**



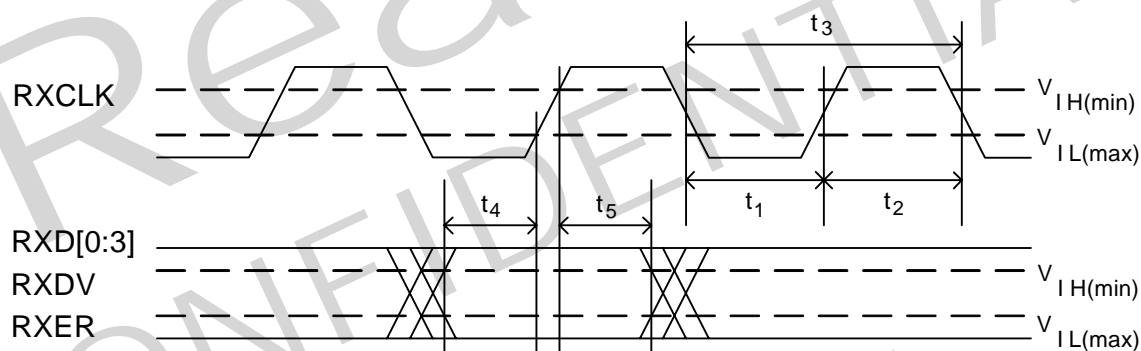
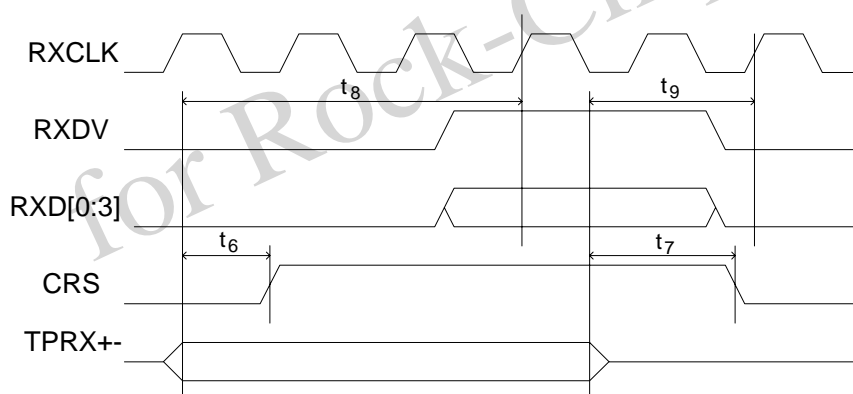
**Figure 23. MII Transmission Cycle Timing-2**

**Table 51. MII Transmission Cycle Timing**

Symbol	Description		Minimum	Typical	Maximum	Unit
$t_1$	TXCLK High Pulse Width	100Mbps	14	20	26	ns
		10Mbps	140	200	260	ns
$t_2$	TXCLK Low Pulse Width	100Mbps	14	20	26	ns
		10Mbps	140	200	260	ns
$t_3$	TXCLK Period	100Mbps	-	40	-	ns
		10Mbps	-	400	-	ns
$t_4$	TXEN, TXD[0:3] Setup to TXCLK Rising Edge	100Mbps	10	-	-	ns
		10Mbps	5	-	-	ns
$t_5$	TXEN, TXD[0:3] Hold After TXCLK Rising Edge	100Mbps	0	-	-	ns
		10Mbps	0	-	-	ns
$t_6$	TXEN Sampled to CRS High	100Mbps	-	-	40	ns
		10Mbps	-	-	400	ns
$t_7$	TXEN Sampled to CRS Low	100Mbps	-	-	160	ns
		10Mbps	-	-	2000	ns

### 9.2.2. MII Reception Cycle Timing

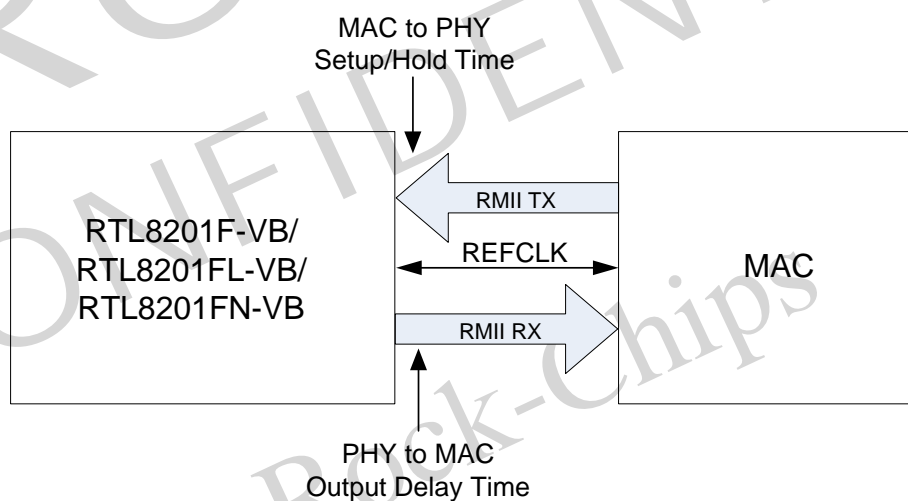
Figure 24 and Figure 25 show an example of a packet transfer from PHY to MAC on the MII interface.


**Figure 24. MII Reception Cycle Timing-1**

**Figure 25. MII Reception Cycle Timing-2**

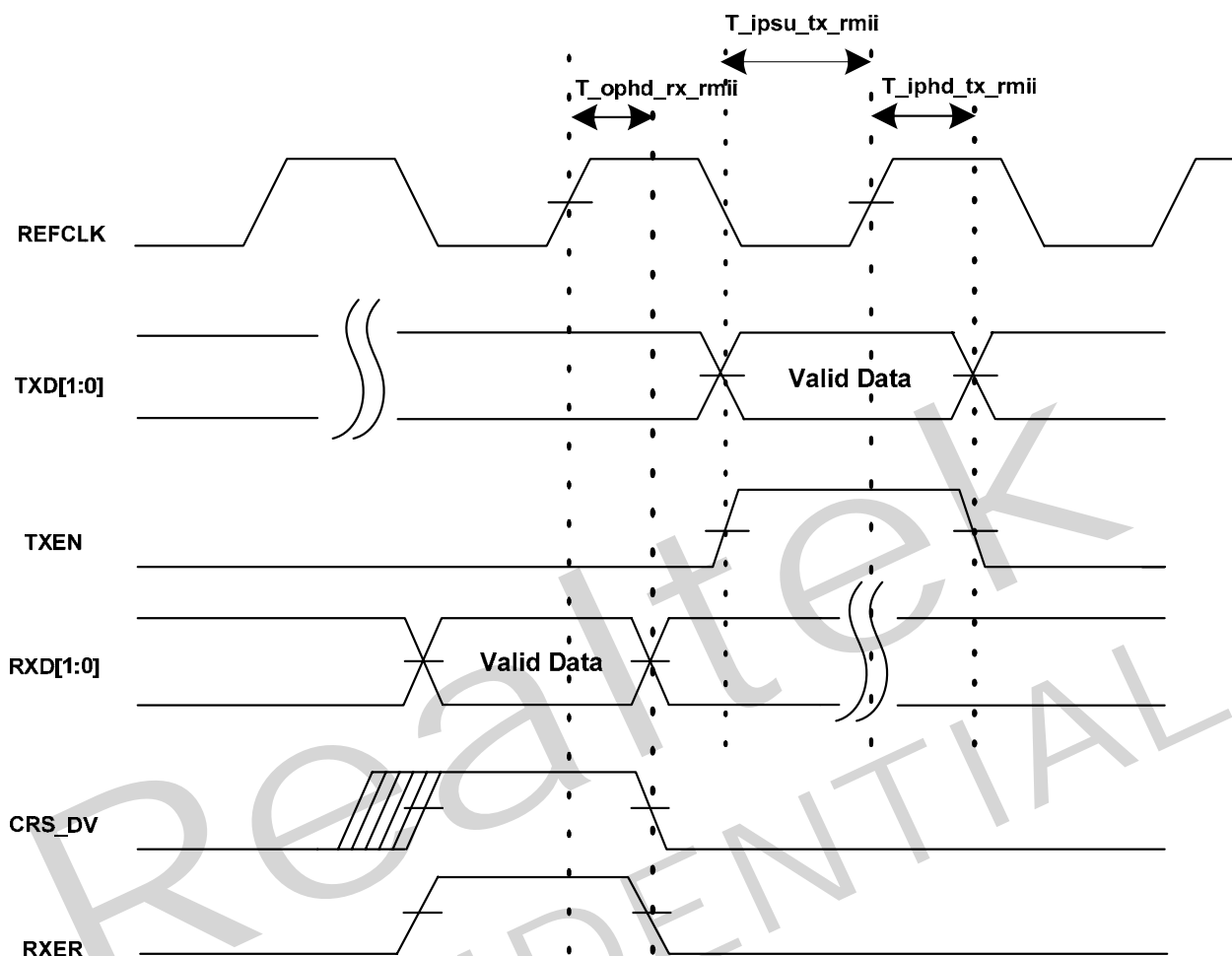
**Table 52. MII Reception Cycle Timing**

Symbol	Description		Minimum	Typical	Maximum	Unit
$t_1$	RXCLK High Pulse Width	100Mbps	14	20	26	ns
		10Mbps	140	200	260	ns
$t_2$	RXCLK Low Pulse Width	100Mbps	14	20	26	ns
		10Mbps	140	200	260	ns
$t_3$	RXCLK Period	100Mbps	-	40	-	ns
		10Mbps	-	400	-	ns
$t_4$	RXER, RXDV, RXD[0:3] Setup to RXCLK Rising Edge	100Mbps	10	-	-	ns
		10Mbps	10	-	-	ns
$t_5$	RXER, RXDV, RXD[0:3] Hold After RXCLK Rising Edge	100Mbps	10	-	-	ns
		10Mbps	10	-	-	ns
$t_6$	Receive Frame to CRS High	100Mbps	-	-	130	ns
		10Mbps	-	-	2000	ns
$t_7$	End of Receive Frame to CRS Low	100Mbps	-	-	240	ns
		10Mbps	-	-	1000	ns
$t_8$	Receive Frame to Sampled Edge of RXDV	100Mbps	-	-	150	ns
		10Mbps	-	-	3200	ns
$t_9$	End of Receive Frame to Sampled Edge of RXDV	100Mbps	-	-	120	ns
		10Mbps	-	-	1000	ns

### 9.2.3. RMII Transmission and Reception Cycle Timing


**Figure 26. RMII Interface Setup, Hold Time, and Output Delay Time Definitions**





**Figure 27. RMIi Transmission and Reception Cycle Timing**

**Table 53. RMIi Transmission and Reception Cycle Timing**

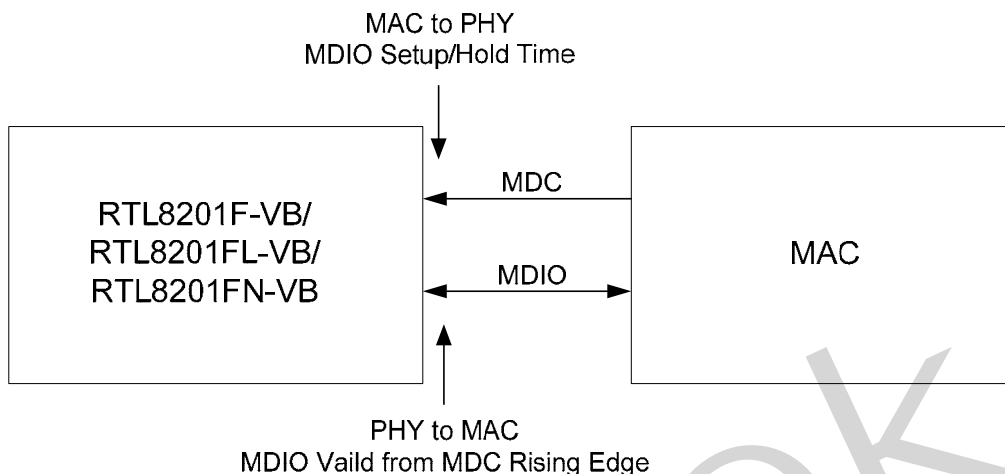
Symbol	Description	Minimum	Typical	Maximum	Unit
REFCLK Frequency	Frequency of Reference Clock	-	50	-	MHz
REFCLK Duty Cycle	Duty Cycle of Reference Clock	35	-	65	%
T_ipsu_tx_rmii	TXD[1:0]/TXEN Setup Time to REFCLK	4	-	-	ns
T_iphd_tx_rmii	TXD[1:0]/TXEN Hold Time from REFCLK	2	-	-	ns
T_ophd_rx_rmii	RXD[1:0]/CRS_DV/RXER Output Delay Time from REFCLK	2	-	-	ns

Note 1: RMIi TX timing can be adjusted by setting page7, register16[11:8]; the minimum adjustable resolution is 2ns. Any changes for these bits are not recommended as the default value is the optimum setting.

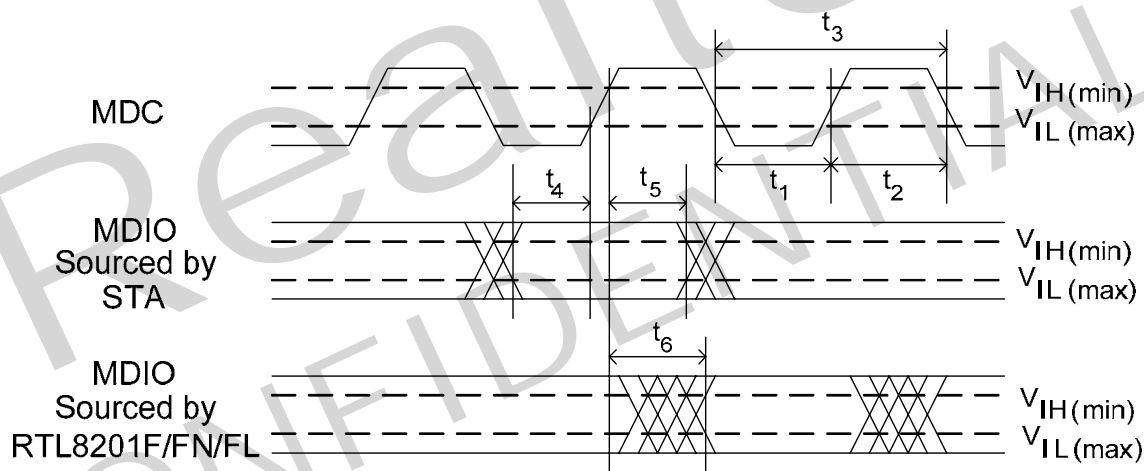
Note 2: RMIi RX timing can be adjusted by setting page7, register16[7:4]; the minimum adjustable resolution is 2ns. Any changes for these bits are not recommended as the default value is the optimum setting.

Note 3: RTL8201Fx-VB-CG default T\_ophd\_rx\_rmii setting is 10 ns.

## 9.2.4. MDC/MDIO Timing



**Figure 28. MDC/MDIO Interface Setup, Hold Time, and Valid from MDC Rising Edge Time Definitions**



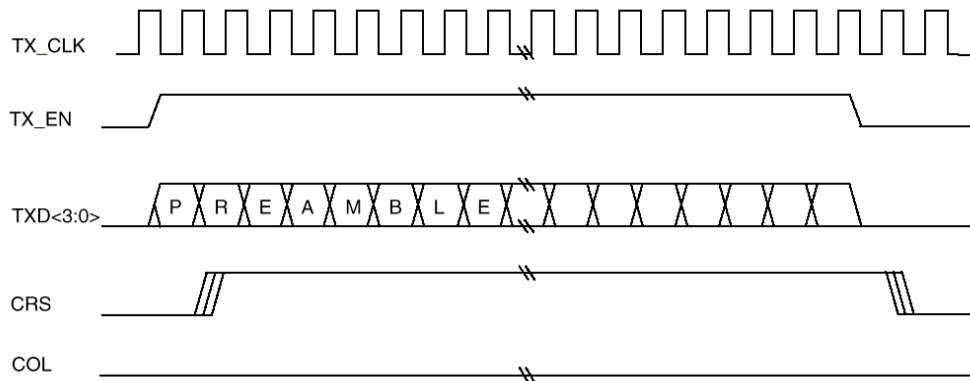
**Figure 29. MDC/MDIO Timing**

**Table 54. MDC/MDIO Timing**

Symbol	Description	Minimum	Maximum	Unit
$t_1$	MDC High Pulse Width	160	-	ns
$t_2$	MDC Low Pulse Width	160	-	ns
$t_3$	MDC Period	400	-	ns
$t_4$	MDIO Setup to MDC Rising Edge	10	-	ns
$t_5$	MDIO Hold Time from MDC Rising Edge	10	-	ns
$t_6$	MDIO Valid from MDC Rising Edge	0	300	ns

### 9.2.5. Transmission without Collision

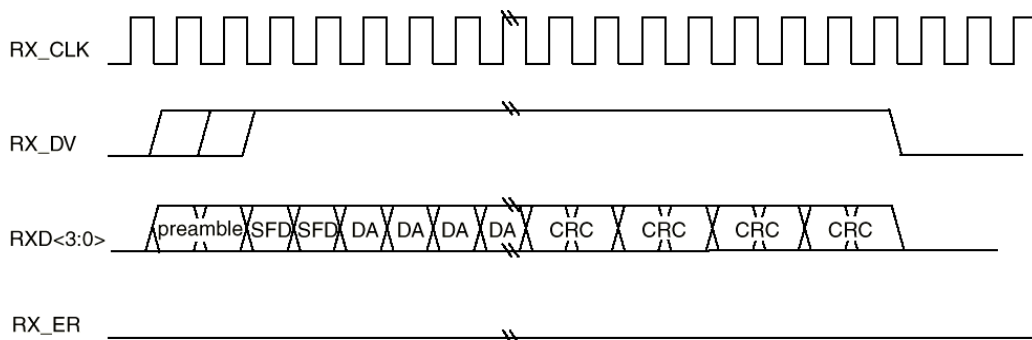
Figure 30 shows an example of a packet transfer from MAC to PHY.



**Figure 30. MAC to PHY Transmission without Collision**

### 9.2.6. Reception without Error

Figure 31 shows an example of a packet transfer from PHY to MAC.



**Figure 31. PHY to MAC Reception Without Error**

### 9.3. Crystal Characteristics

**Table 55. Crystal Characteristics**

Symbol	Description/Condition	Minimum	Typical	Maximum	Unit
F <sub>ref</sub>	Parallel Resonant Crystal Reference Frequency, Fundamental Mode, AT-Cut Type.	-	25	-	MHz
F <sub>ref</sub> Stability	Parallel Resonant Crystal Frequency Stability, Fundamental Mode, AT-Cut Type. T <sub>a</sub> =0°C~70°C.	-30	-	+30	ppm
F <sub>ref</sub> Tolerance	Parallel Resonant Crystal Frequency Tolerance, Fundamental Mode, AT-Cut Type. T <sub>a</sub> =25°C.	-50	-	+50	ppm
F <sub>ref</sub> Duty Cycle	Reference Clock Input Duty Cycle.	40	-	60	%
ESR	Equivalent Series Resistance.	-	-	30	Ω
DL	Drive Level.	-	-	0.3	mW
Jitter	Broadband Peak-to-Peak Jitter <sup>1, 2</sup>	-	-	500	ps

Note 1: 25KHz to 25MHz RMS < 3ps.

Note 2: Broadband RMS < 9ps.

### 9.4. Oscillator Requirements

**Table 56. Oscillator Requirements**

Parameter	Condition	Minimum	Typical	Maximum	Unit
Frequency	-	-	25/50	-	MHz
Frequency Stability	T <sub>a</sub> = 0°C~+70°C	-30	-	30	ppm
Frequency Tolerance	T <sub>a</sub> = 25°C	-50	-	50	ppm
Duty Cycle	-	40	-	60	%
Broadband Peak-to-Peak Jitter <sup>1, 2</sup>	-	-	-	500	ps
V <sub>IH</sub>	-	1.4	-	-	V
V <sub>IL</sub>	-	-	-	0.4	V
Rise Time (10%~90%)	-	-	-	10	ns
Fall Time (10%~90%)	-	-	-	10	ns
Operating Temperature Range	-	0	-	70	°C

Note 1: 25KHz to 25MHz RMS < 3ps.

Note 2: Broadband RMS < 9ps.

## 9.5. Clock Requirements

**Table 57. Clock Requirements**

Parameter	Minimum	Typical	Maximum	Unit
Frequency	-	25/50	-	MHz
Frequency Stability	-30	-	30	ppm
Frequency Tolerance	-50	-	50	ppm
Duty Cycle	40	-	60	%
Broadband Peak-to-Peak Jitter <sup>1, 2</sup>	-	-	500	ps
V <sub>IH</sub>	1.4	-	-	V
V <sub>IL</sub>	-	-	0.4	V
Rise Time (10%~90%)	-	-	10	ns
Fall Time (10%~90%)	-	-	10	ns

Note 1: 25KHz to 25MHz RMS < 3ps.

Note 2: Broadband RMS < 9ps.

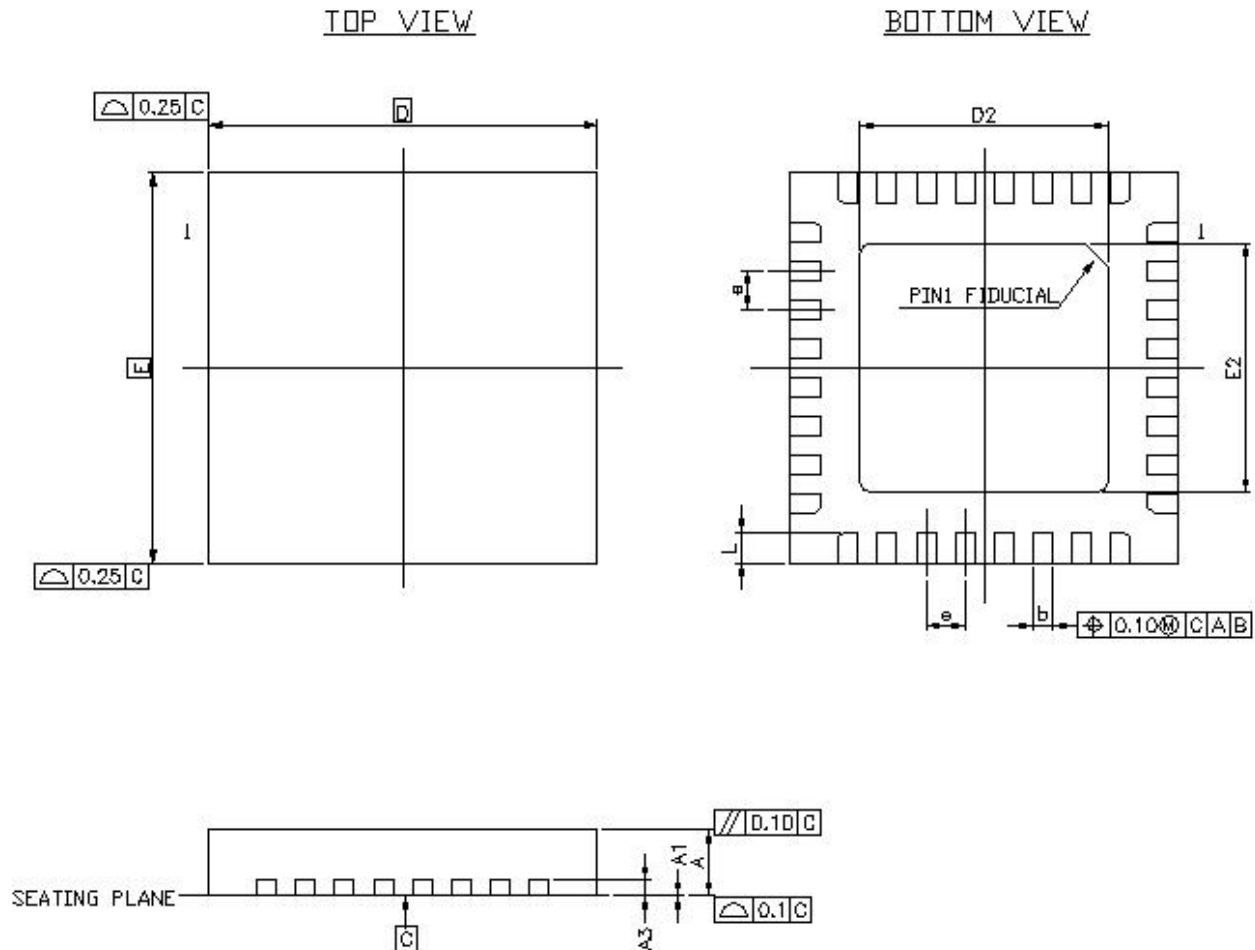
## 9.6. Transformer Characteristics

**Table 58. Transformer Characteristics**

Parameter	Transmit End	Receive End
Turn Ratio	1:1 CT	1:1 CT
Inductance (min.)	350μH @ 8mA	350μH @ 8mA

## 10. Mechanical Dimensions

### 10.1. RTL8201F (QFN-32)

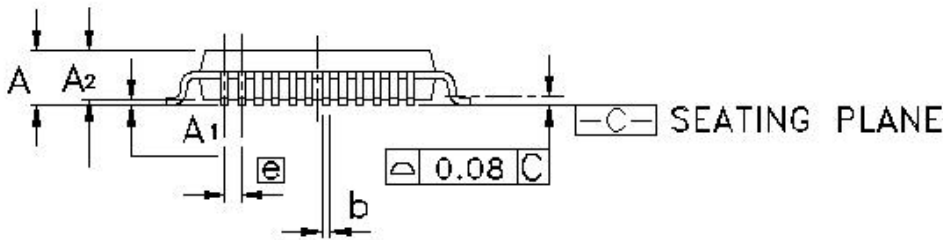
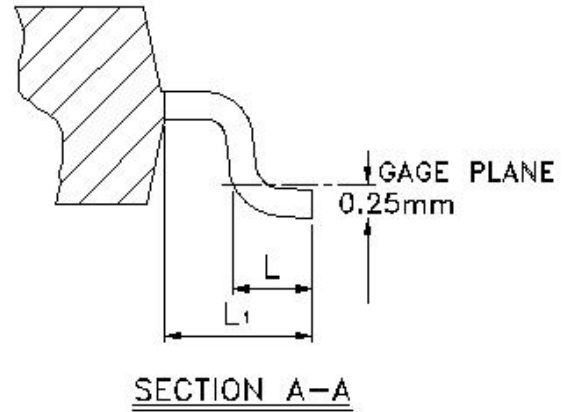
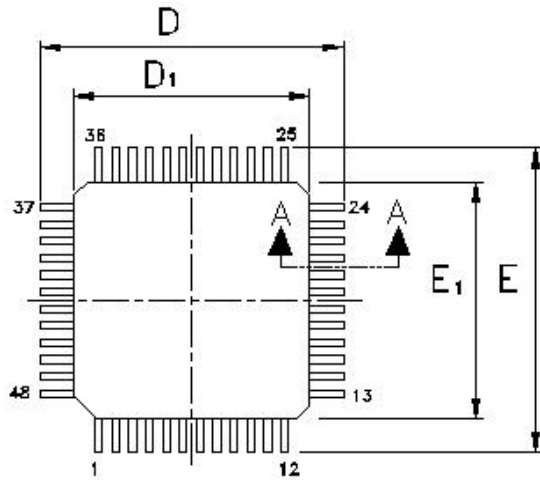


Symbol	Dimension in mm			Dimension in inch		
	Min	Nom	Max	Min	Nom	Max
A	0.75	0.85	1.00	0.030	0.034	0.039
A <sub>1</sub>	0.00	0.02	0.05	0.000	0.001	0.002
A <sub>3</sub>	0.20REF			0.008REF		
b	0.18	0.25	0.30	0.007	0.010	0.012
c	-	-	0.6	-	-	0.024
D/E	5.00BSC			0.197BSC		
D <sub>2</sub> /E <sub>2</sub>	3.10	3.35	3.60	0.122	0.132	0.142
e	0.50BSC			0.020BSC		
L	0.30	0.40	0.50	0.012	0.016	0.020

Note 1: CONTROLLING DIMENSION: MILLIMETER (mm).

Note 2: REFERENCE DOCUMENT: JEDEC MO-220.

## 10.2. RTL8201FL (LQFP-48)



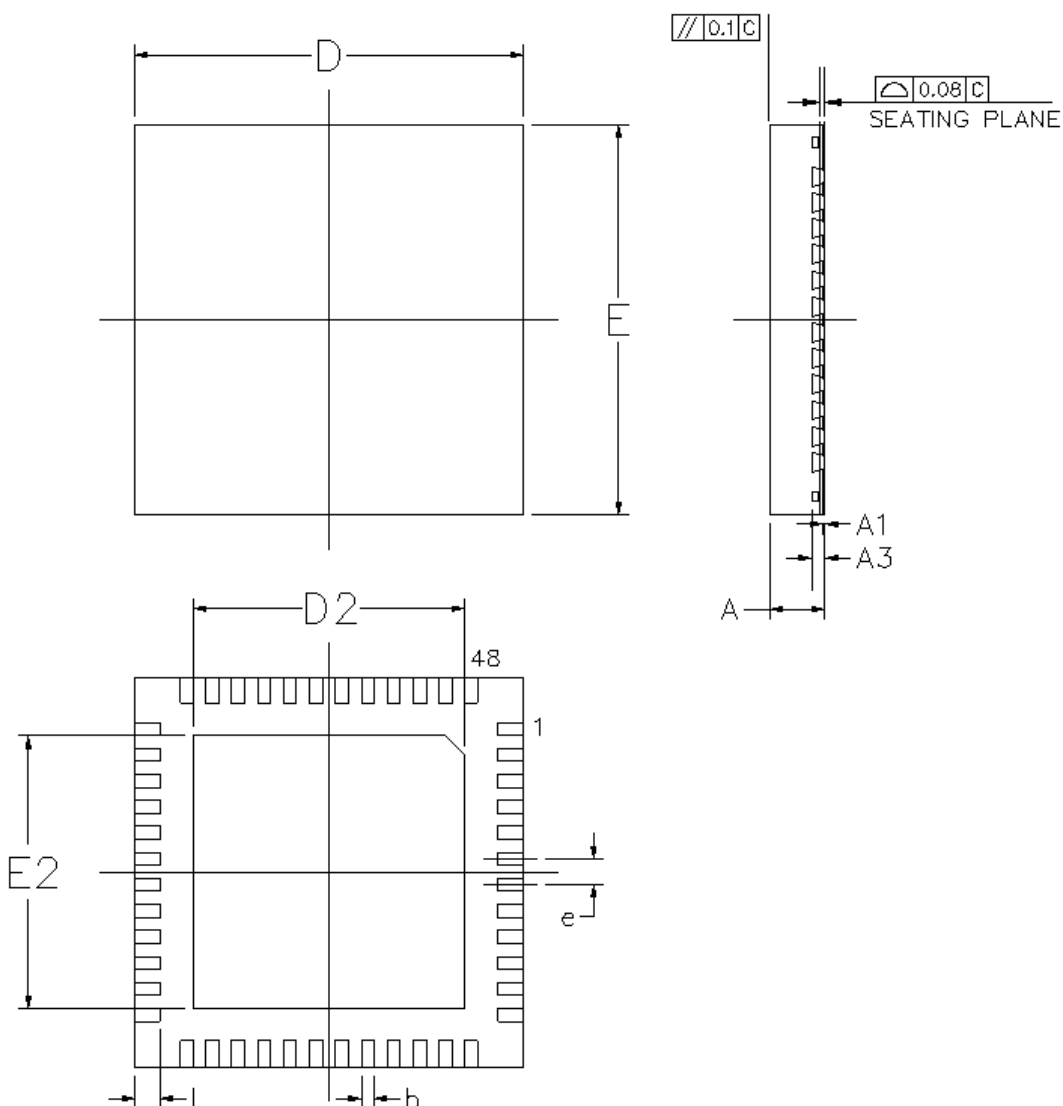
Symbol	Dimension in mm			Dimension in inch		
	Min	Nom	Max	Min	Nom	Max
A	-	-	1.60	-	-	0.063
A <sub>1</sub>	0.05	-	0.15	0.002	-	0.006
A <sub>2</sub>	1.35	1.40	1.45	0.053	0.055	0.057
b	0.17	0.22	0.27	0.007	0.009	0.011
D/E	9.00BSC			0.354BSC		
D <sub>1</sub> /E <sub>1</sub>	7.00BSC			0.276BSC		
e	0.50BSC			0.020BSC		
L	0.45	0.60	0.75	0.018	0.024	0.030
L1	1.00REF			0.039REF		

Note 1: CONTROLLING DIMENSION: MILLIMETER (mm).

Note 2: REFERENCE DOCUMENT: JEDEC MS-026.



### 10.3. RTL8201FN (QFN-48)



Symbol	Dimension in mm			Dimension in inch		
	Min	Nom	Max	Min	Nom	Max
A	0.75	0.85	1.00	0.030	0.034	0.039
A <sub>1</sub>	0.00	0.02	0.05	0.000	0.001	0.002
A <sub>3</sub>	0.20REF			0.008REF		
b	0.15	0.20	0.25	0.006	0.008	0.010
D/E	6.00BSC			0.236BSC		
D <sub>2</sub> /E <sub>2</sub>	4.05	4.4	4.65	0.163	0.173	0.183
e	0.40BSC			0.016BSC		
L	0.30	0.40	0.50	0.012	0.016	0.020

Note 1: CONTROLLING DIMENSION: MILLIMETER (mm).

Note 2: REFERENCE DOCUMENT: JEDEC MO-220.

## 11. Ordering Information

**Table 59. Ordering Information**

Part Number	Package	Status
RTL8201F-VB-CG	32-Pin QFN 'Green' Package (for details see Table 60 below)	MP
RTL8201FL-VB-CG	48-Pin LQFP 'Green' Package (for details see Table 60 below)	MP
RTL8201FN-VB-CG	48-Pin QFN 'Green' Package (for details see Table 60 below)	MP

Note: See page 5, 6, and 7 for package identification.

### 11.1. RTL8201F Series Selection Guide

**Table 60. RTL8201F Series Selection Guide**

Part Number	Interface	Package	WOL (PMEB Pin)	REF_CLK Direction H/W Strap	EEE	INTB	Number of LEDs	Co-Layout Solution
RTL8201F-VB-CG	RMII MII	QFN32	Yes	Yes	Yes	Yes*	2	RTL8201E-VC
RTL8201FL-VB-CG	RMII MII	LQFP48	Yes	Yes	Yes	Yes	2	RTL8201EL RTL8201EL-VC
RTL8201FN-VB-CG	RMII MII	QFN48	Yes	Yes	Yes	Yes	3	RTL8211D-VB RTL8211E-VB RTL8201EN-VC

Note: The RTL8201F INTB pin is used for the interrupt function only when in the RMII mode.

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